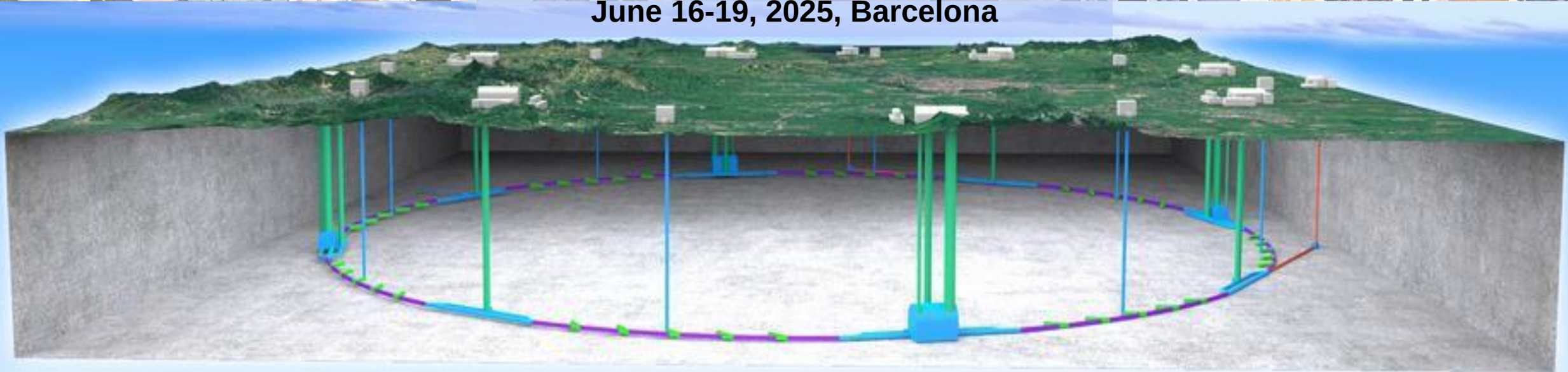


TDR of A Reference CEPC Detector

Jianchun Wang (IHEP, CAS)
For the CEPC Study Group

CEPC International Workshop, EU Edition
June 16-19, 2025, Barcelona



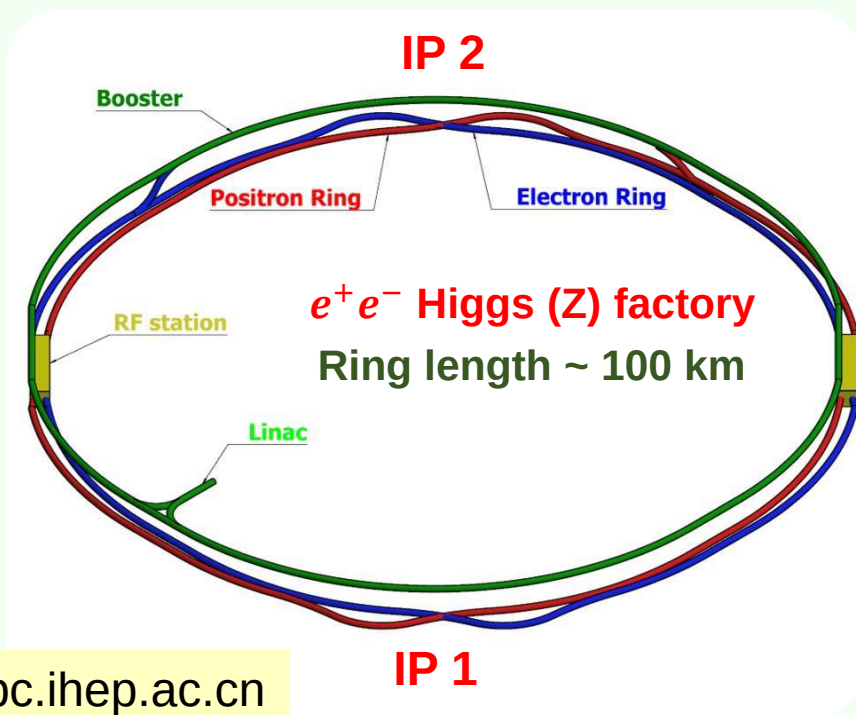


- ❑ Motivation of A Reference CEPC Detector TDR
- ❑ Baseline Technology Selections
- ❑ Status of R&D Projects
- ❑ R&D Team and International Collaborative Efforts
- ❑ Timeline of The Ref-TDR

Refer to the presentation at this workshop
[CEPC Accelerator EDR Status and Beyond](#) Jie Gao

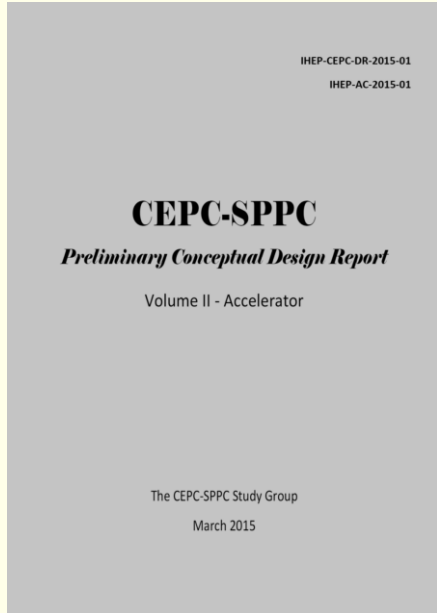


- ❑ The CEPC was proposed in 2012 right after the Higgs discovery. It aims to start operation in 2030s, as an e^+e^- Higgs / Z factory.
- ❑ To produce Higgs / W / Z / top for high precision Higgs, EW measurements, studies of flavor physics & QCD, and probes of physics BSM.
- ❑ It is possible to upgrade to a pp collider (SppC) of $\sqrt{s} \sim 100$ TeV in the future.

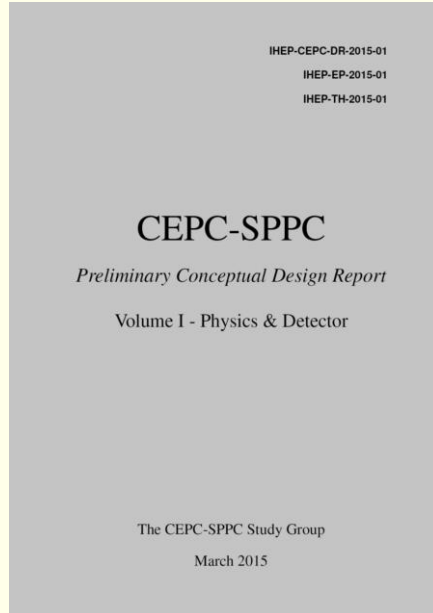


<http://cepc.ihep.ac.cn>



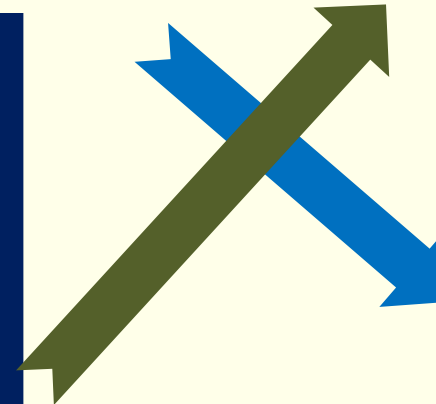
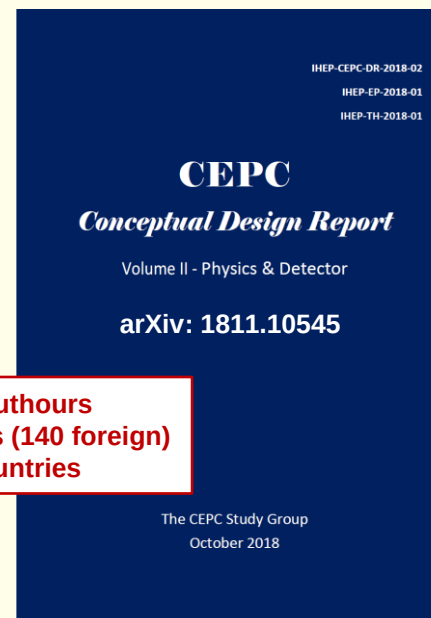
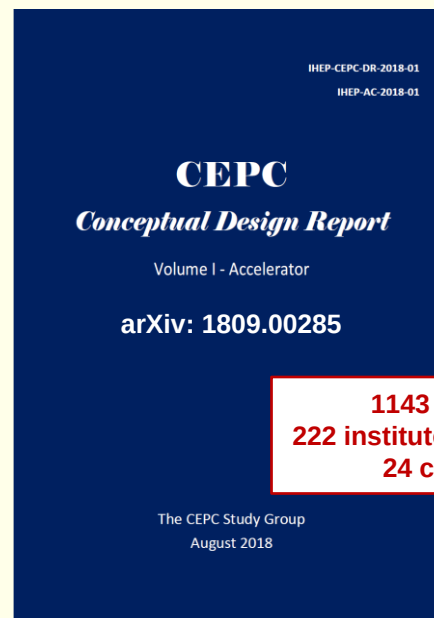
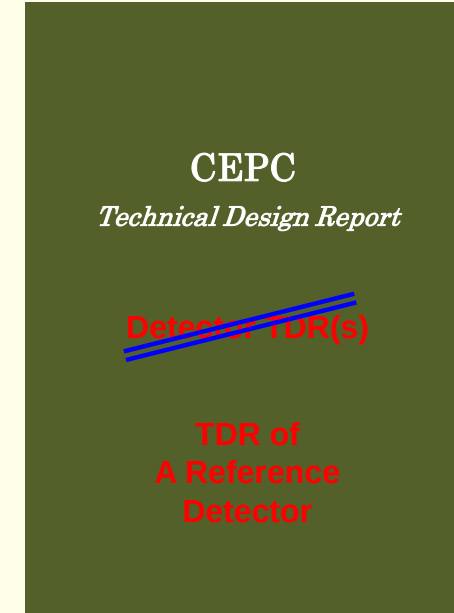
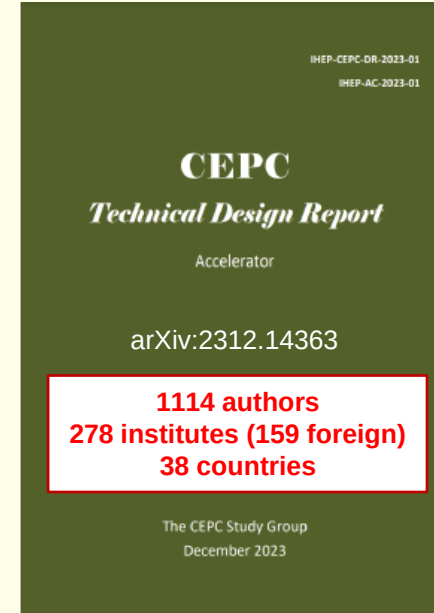


**Pre-CDR Released
(2015.03)**



**Accelerator
TDR Released
(2023.12)**

**CDR Released
(2018.11)**



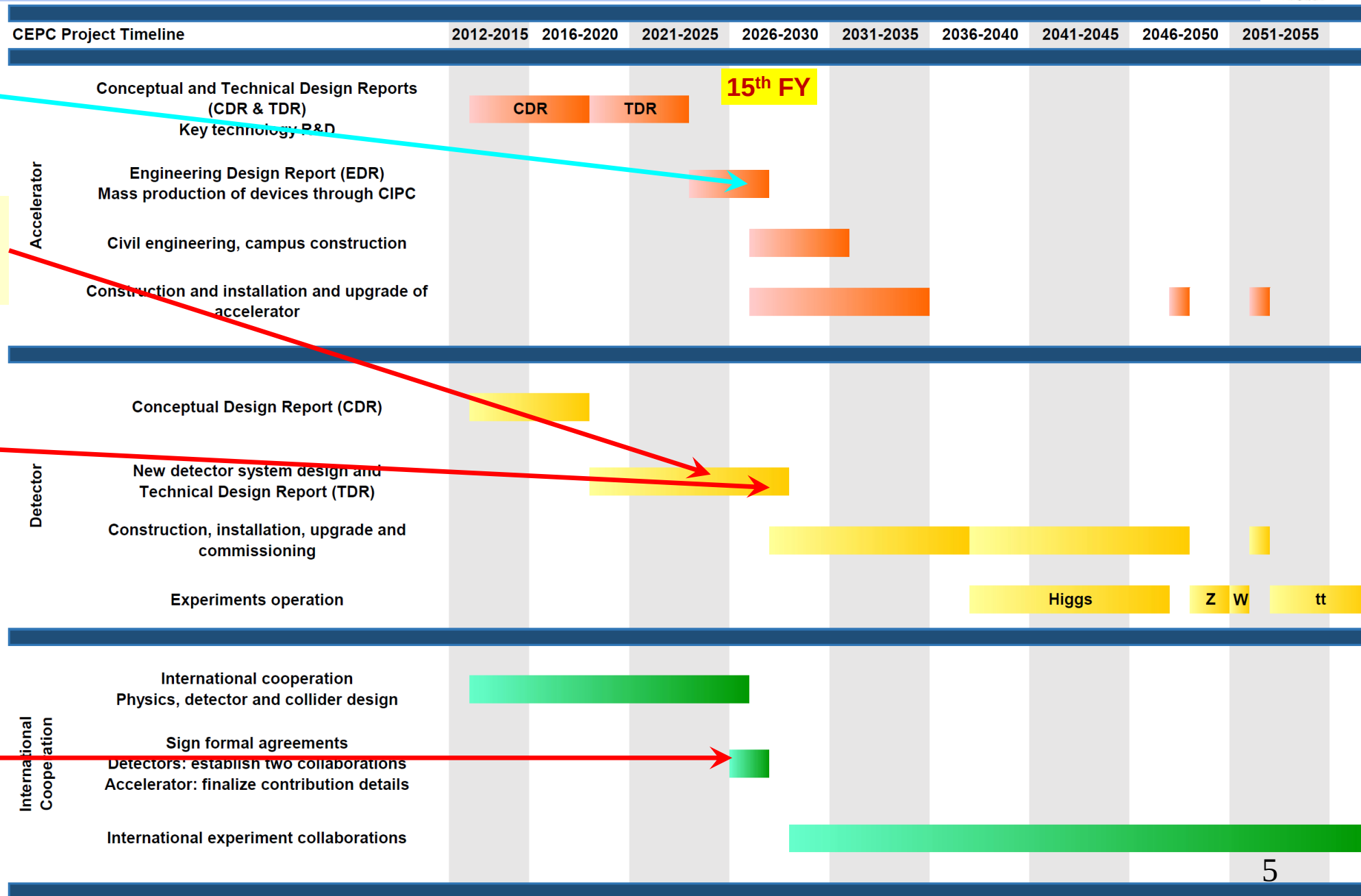
Completion of Accelerator EDR

Release TDR of A Reference Detector

Detector TDR × 2

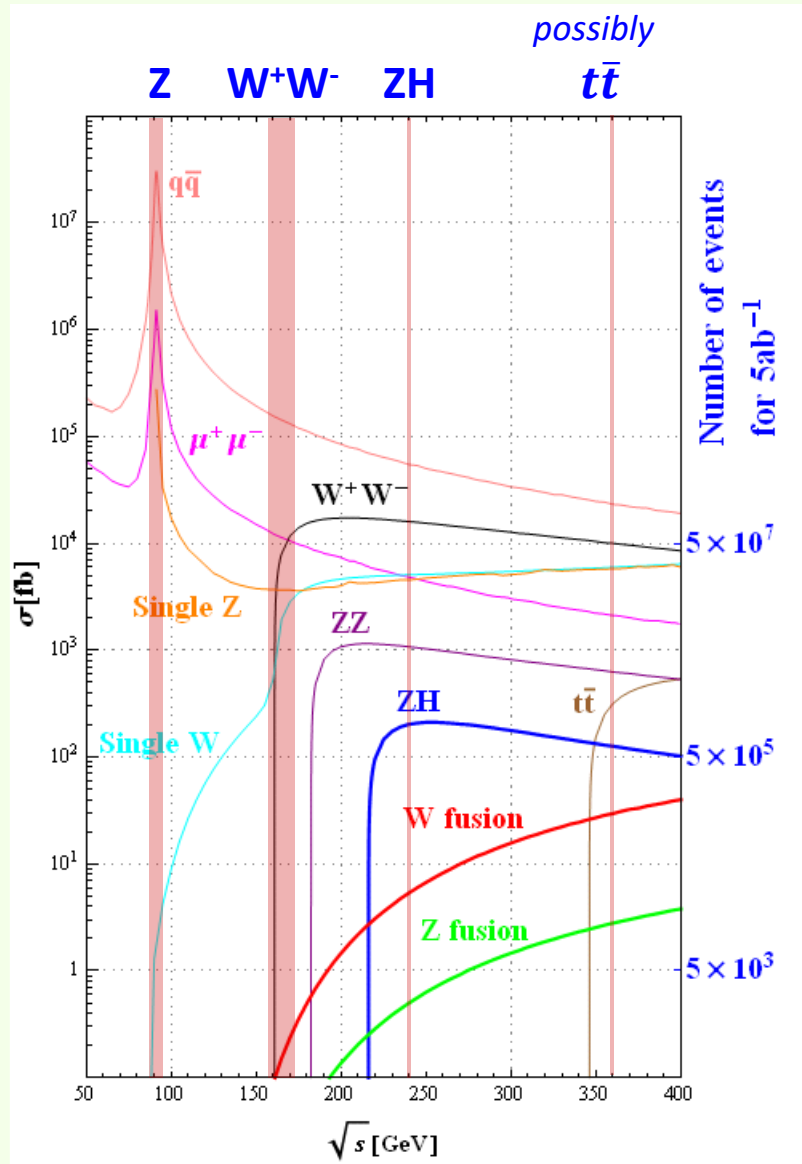
Most Higgs factory detector systems are generic, e.g. ILD, IDEA

International Collaborations



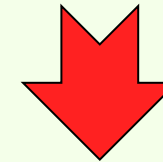


- ❑ The Ref-TDR needs to be released in a timely fashion, to **boost the possibility** of receiving an official endorsement for the 15th FYP
- ❑ The Ref-TDR mainly serves a **special purpose**, and is not to replace the TDRs for the real experiments. When the two international collaborations form, they will converge on the designs and deliver the corresponding detector TDRs.
- ❑ We treat it as a TDR of a real detector system to be built soon
 - Demonstrate the readiness and feasibility of detector technologies
 - Provide a realistic detector cost estimation
 - Assess requirements and availabilities of people power
- ❑ The exercise and efforts on the Ref-TDR will be very valuable assets, not only in technology development but also in team building.



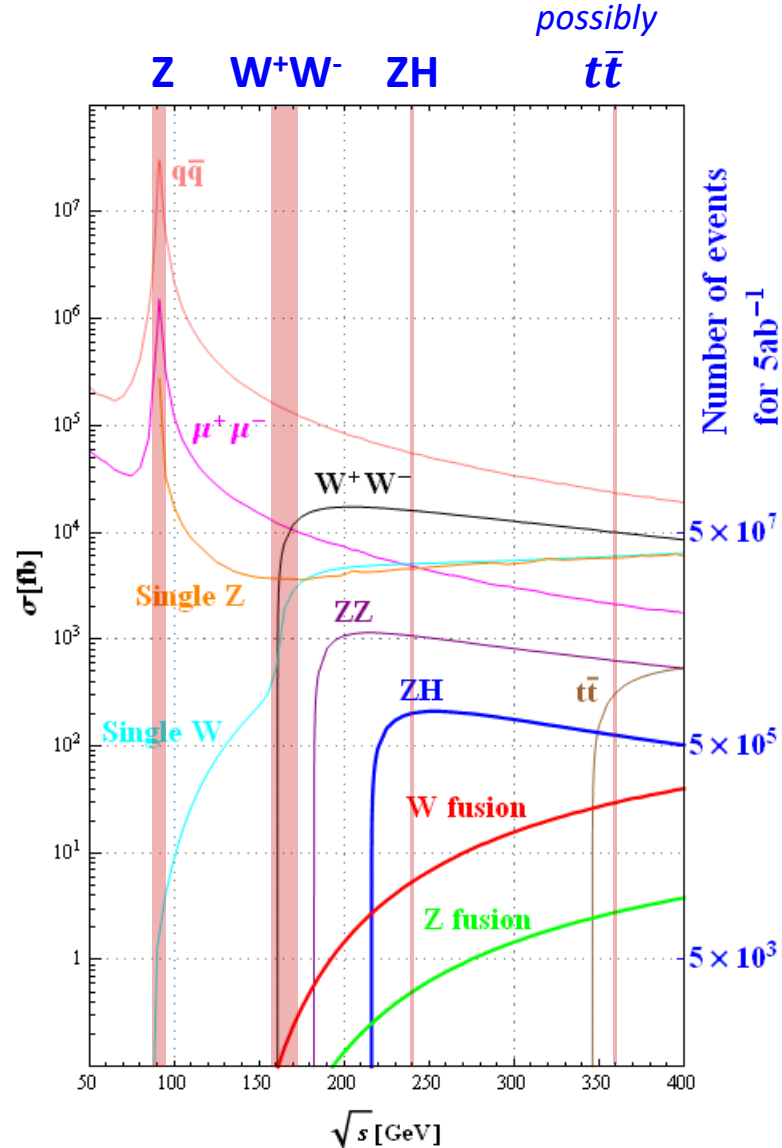
Operation mode		ZH	Z	W^+W^-	$t\bar{t}$
$\sqrt{s}$ [GeV]		~240	~91	~160	~360
Run Time [years]		10	2	1	5
30 MW	L / IP [$\times 10^{34} \text{ cm}^{-2}\text{s}^{-1}$]	5.0	115	16	0.5
	$\int L dt$ [ab^{-1} , 2 IPs]	13	60	4.2	0.65
	Event yields [2 IPs]	2.6×10^6	2.5×10^{12}	1.3×10^8	4×10^5
50 MW	L / IP [$\times 10^{34} \text{ cm}^{-2}\text{s}^{-1}$]	8.3	192	26.7	0.8
	$\int L dt$ [ab^{-1} , 2 IPs]	21.6	100	6.9	1
	Event yields [2 IPs]	4.3×10^6	4.1×10^{12}	2.1×10^8	6×10^5

CEPC accelerator TDR (Xiv:2312.14363)



CEPC Physics White Papers

- Precision Higgs Physics at CEPC ([CPC V43, No. 4 \(2019\) 043002](#))
- Flavor Physics at CEPC ([arXiv:2412.19743](#))
- New Physics Search at CEPC ([arXiv:2505.24810](#))



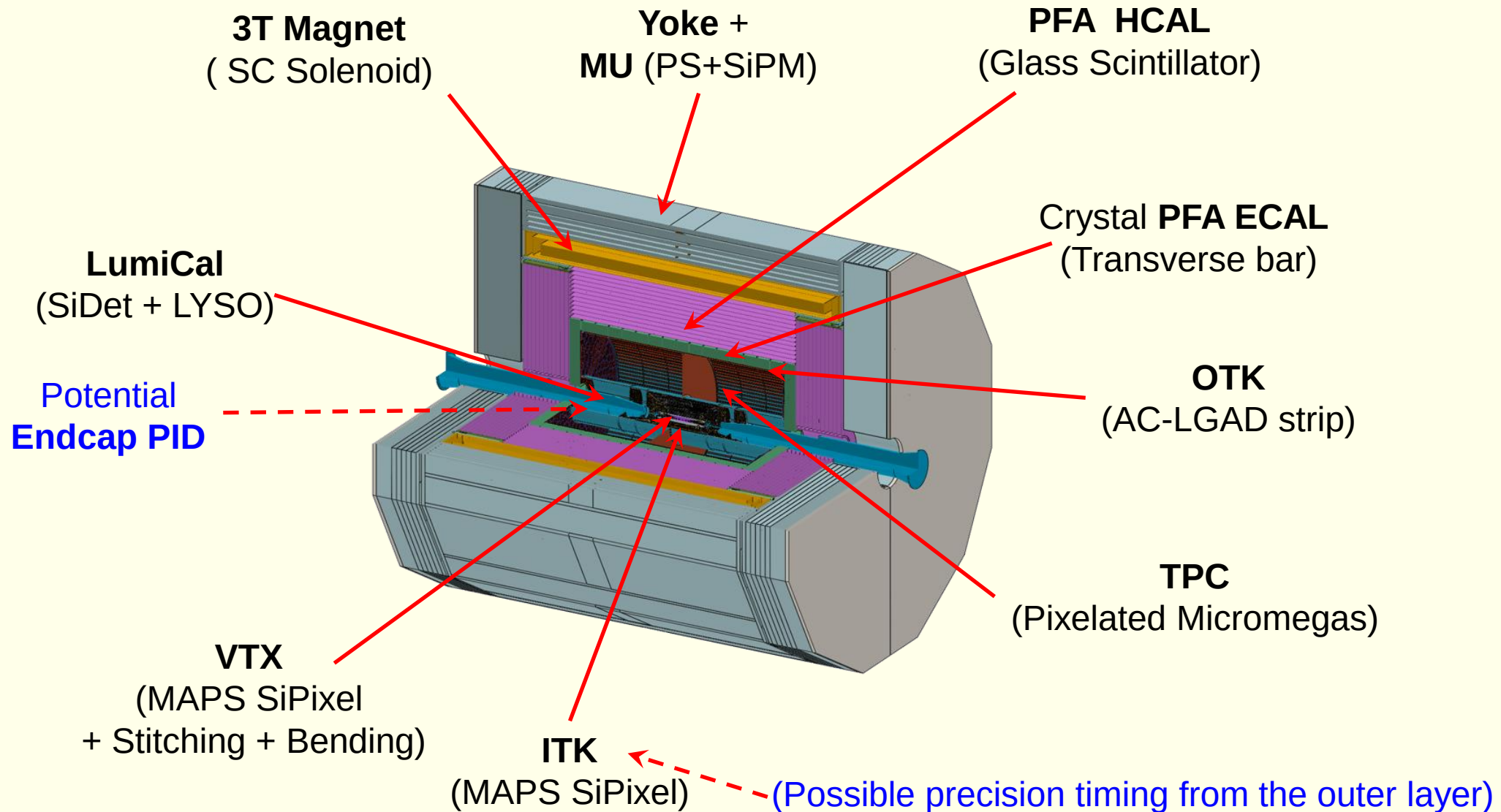
SR Power Per Beam	Luminosity/IP [$\times 10^{34} \text{cm}^{-2} \text{s}^{-1}$]		
	H	Z	W ⁺ W ⁻
12.1 MW	-	26	-
30 MW	5.0	-	16
50 MW	8.3	-	26.7

B = 3T
all modes

- **The first 10-year operation** includes: the Higgs mode, Low-Lumin Z mode, and W⁺W⁻ mode.
- The accelerator may be upgraded for High-Lumi Z mode and t $\bar{t}$ mode after 10 years operation, subject to physics needs
- The reference detector focuses on the first 10 years operation. There may be future upgrade of the detector if the accelerator is to be upgraded



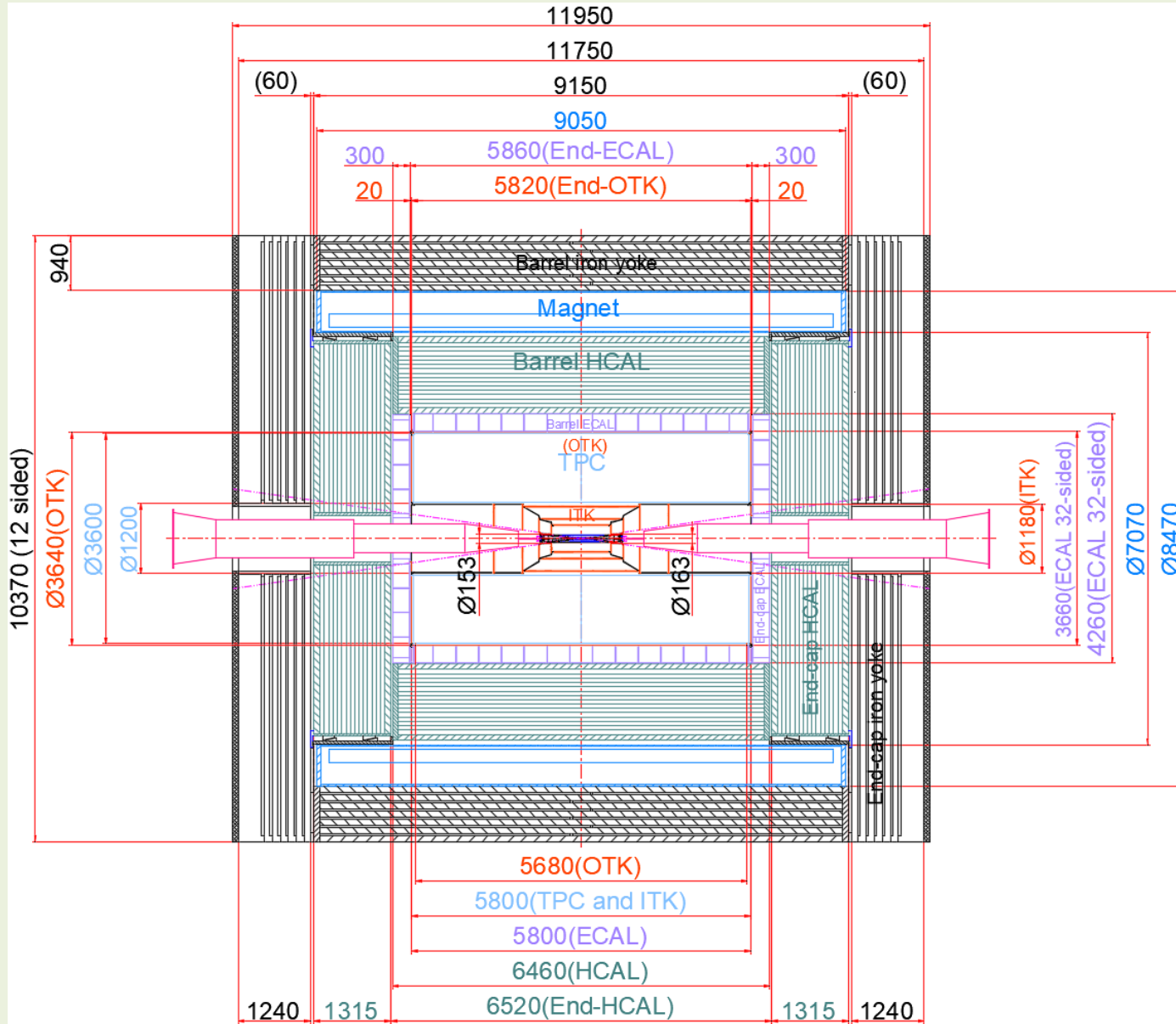
- ❑ The detectors should be able to operate for at least **10 years** in Higgs mode, or better **~18 years** of HZ, Z, W^+W^- , and $t\bar{t}$ productions.
- ❑ The detectors should be optimized to operate at the CEPC base clock frequency of **43.3 MHz** (or period = 23.1 ns).
- ❑ The system needs to select and record interesting physics events.
 - In Higgs mode and L / IP (50 MW) = $8.3 \times 10^{34} \text{ cm}^{-2}\text{s}^{-1}$:
beam-beam crossing rate $\sim 1.34 \text{ MHz}$, $ZH \sim 16.6 \text{ mHz}$, $q\bar{q} \sim 5.0 \text{ Hz}$
 - In Z mode and L / IP (50 MW) = $1.92 \times 10^{36} \text{ cm}^{-2}\text{s}^{-1}$:
beam-beam crossing $\sim 39.3 \text{ MHz}$, visible Z $\sim 66 \text{ kHz}$
- ❑ Detectors can endure **radiation** damage and **noise hit** rates.
 - For example, in the Higgs mode at the Vertex detector:
max noise hit rate $\sim 0.6 \text{ MHz / cm}^2$, TID $\sim 2.1 \text{ Mrad/year}$
 - The background study is very preliminary. The value can be off by an order of magnitude.
 - It is a relatively relaxed environment comparing to a hadron collider. Radiation resilience and noise hit rate should not be huge problems.





Sub-system	Key technology	Key Specifications
Vertex	6-layer CMOS SPD	$\sigma_{r\phi} \sim 3 \mu\text{m}$, $X/X_0 < 0.15\%$ per layer
Tracking	CMOS SPD ITK, AC-LGAD SSD OTK, TPC + Vertex detector	$\sigma\left(\frac{1}{P_T}\right) \sim 2 \times 10^{-5} \oplus \frac{1 \times 10^{-3}}{P \times \sin^{3/2} \theta} (\text{GeV}^{-1})$
Particle ID	dN/dx measurements by TPC Time of flight by AC-LGAD SSD	Relative uncertainty $\sim 3\%$ $\sigma(t) \sim 30 \text{ ps}$
EM calorimeter	High granularity crystal bar PFA calorimeter	EM resolution $\sim 3\%/\sqrt{E(\text{GeV})}$ Granularity $\sim 1 \times 1 \times 2 \text{ cm}^3$
Hadron calorimeter	Scintillation glass PFA hadron calorimeter	Support PFA jet reconstruction Single hadron $\sigma_E^{had} \sim 40\%/\sqrt{E(\text{GeV})}$ Jet $\sigma_E^{jet} \sim 30\%/\sqrt{E(\text{GeV})}$

- ❖ Design of the CEPC detector evolves with the R&D progressing and our better understanding of the physics reach.
- ❖ The key specifications continue to be optimized.



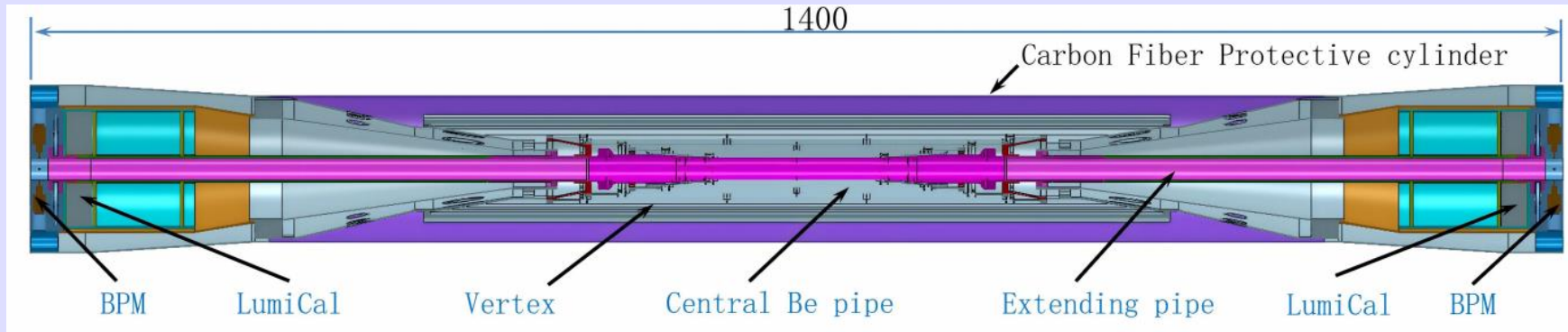
Subsystem	Supported By
Barrel Yoke	Base
Magnet	Barrel Yoke
Barrel HCAL	Barrel Yoke
Barrel ECAL	Barrel HCAL
TPC+ Barrel OTK	Barrel ECAL
ITK	TPC
Beampipe+VTX+LumiCal	ITK
Endcap Yoke	Base
Endcap HCAL	Barrel HCAL
Endcap ECAL+OTK	Barrel HCAL

Detector Overall

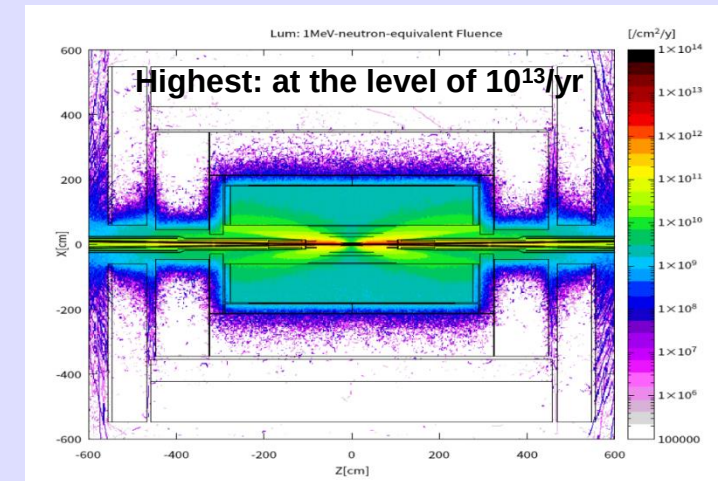
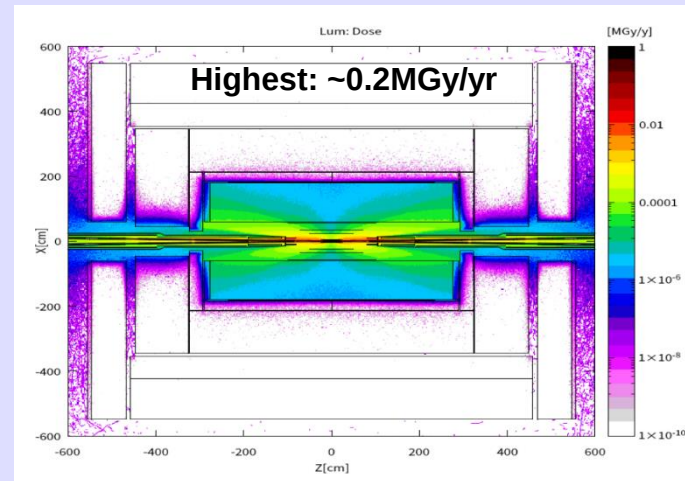
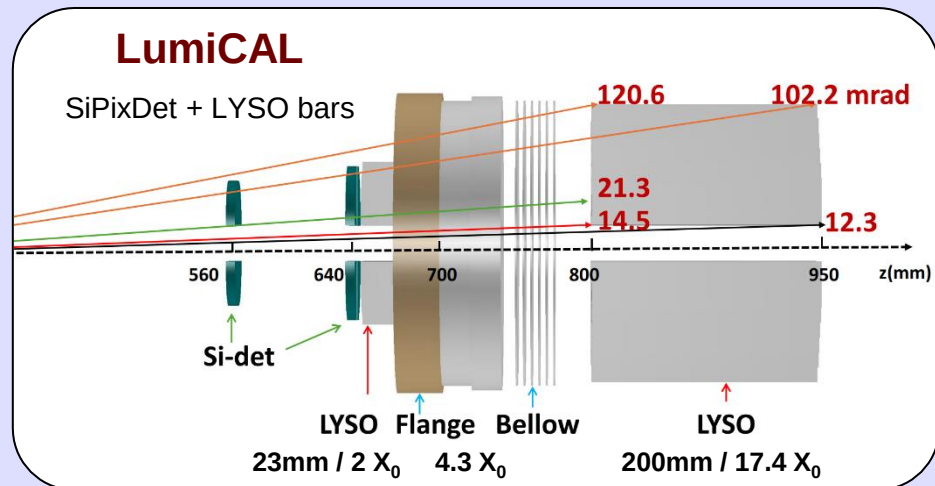
Length: 11,950 mm

Height: 10,370 mm

Weight: 5,290 t

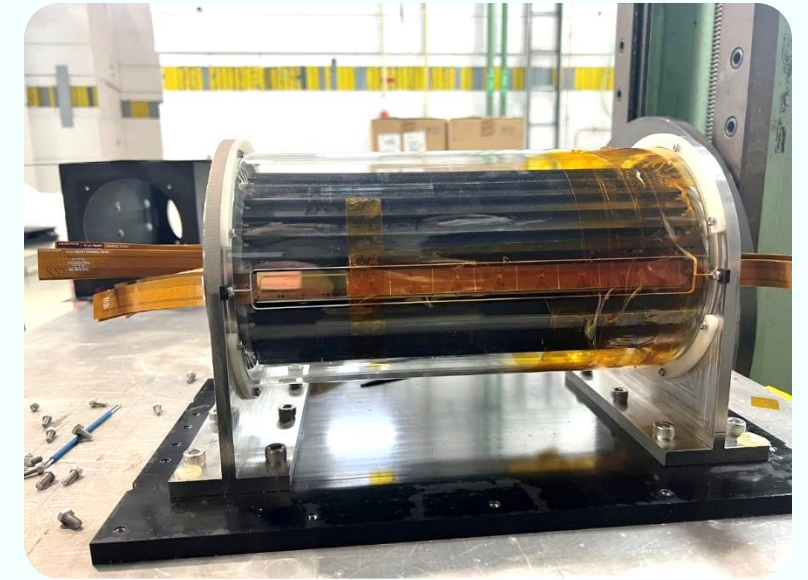


- ❑ Design of the CEPC interaction region, beam pipe and LumiCal
- ❑ LYSO bar and SPD based LumiCal design for a 10^{-4} luminosity precision, yet to be validated.
- ❑ Beam-induced background and radiation levels are estimated with updated model and improved design of collimators and shielding





**Strong
collaboration
from IFAE**



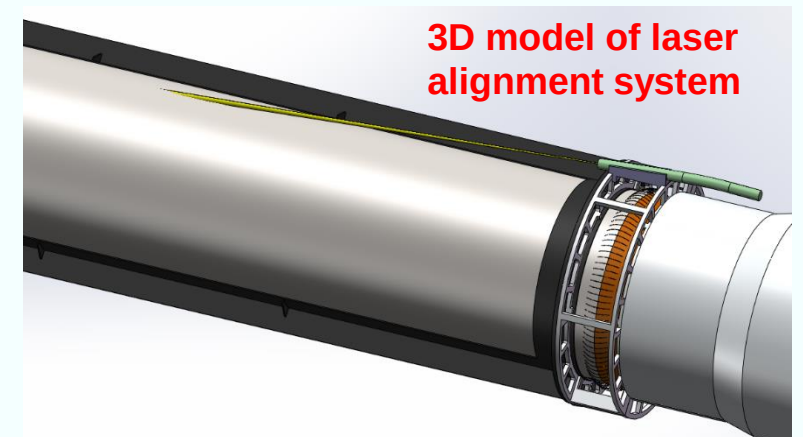
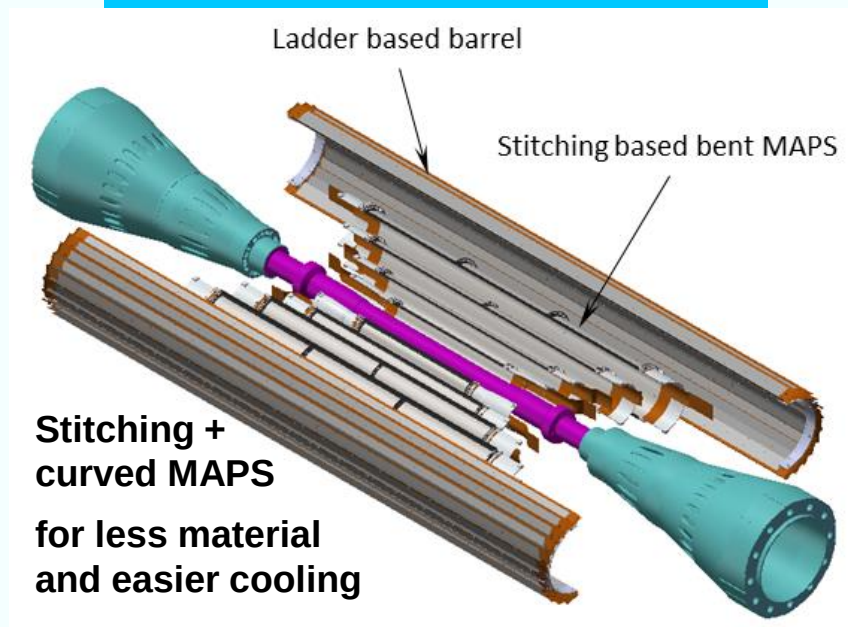
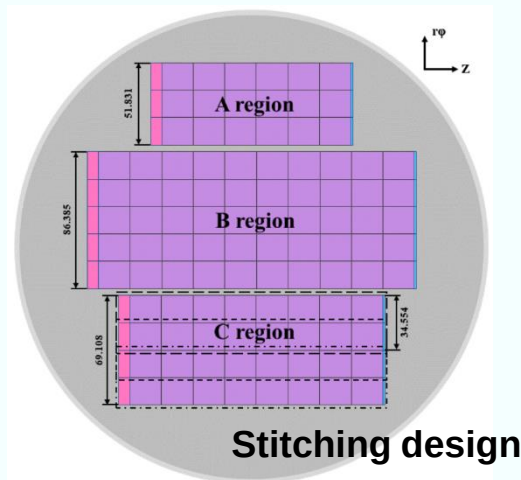
A TaichuPix-based prototype detector



Goal: $\sigma(\text{IP}) \sim 5 \mu\text{m}$ for high P

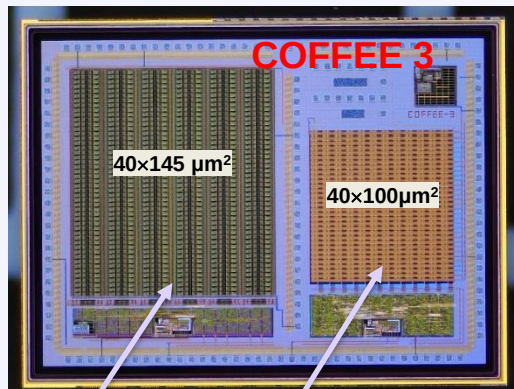
Key specifications:

- Single point resolution $\sim 3 \mu\text{m}$
- Low material ($0.15\% X_0$ / layer)
- Low power ($< 50 \text{ mW/cm}^2$)



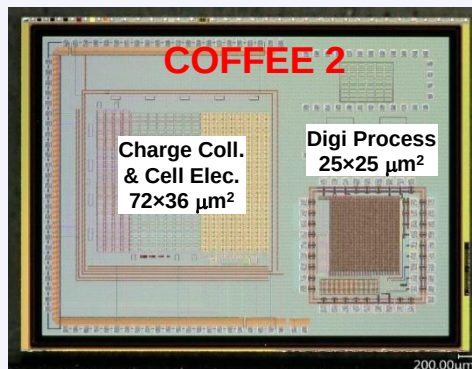


- ❑ Focus on HV-CMOS pixel detector of $\sim 15\text{-}20\text{ m}^2$.
- ❑ Exploring SMIC 55 nm and other processes
 - COFFEE2: 1st prototype as validation of process
 - COFFEE3: just produced, with full digital functions
- ❑ Overall detector design based on typical chip size



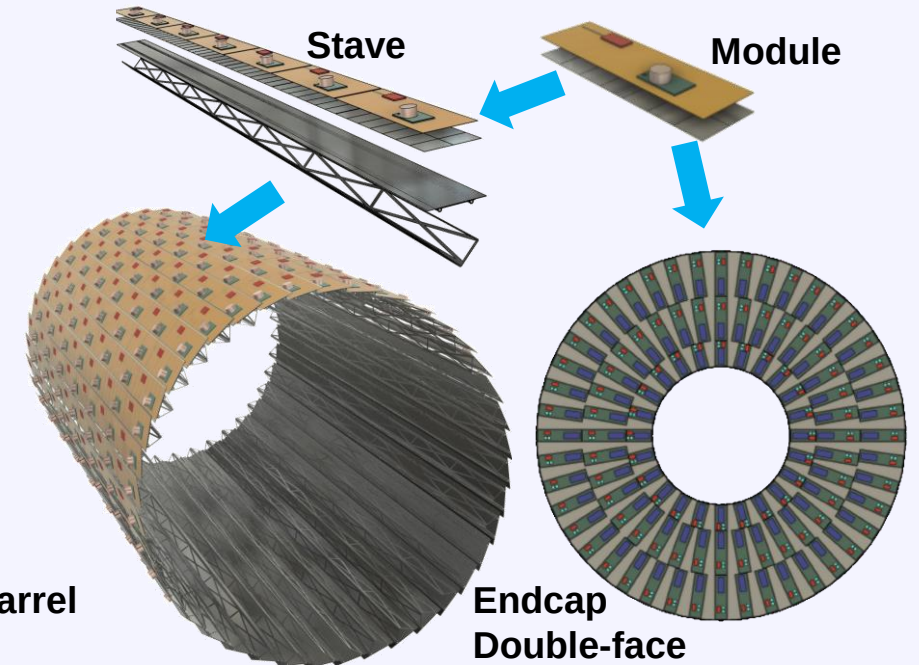
Architecture with
in-pixel TDC for
optimal timing

Digital functions in
periphery for minimal
interference w. signal

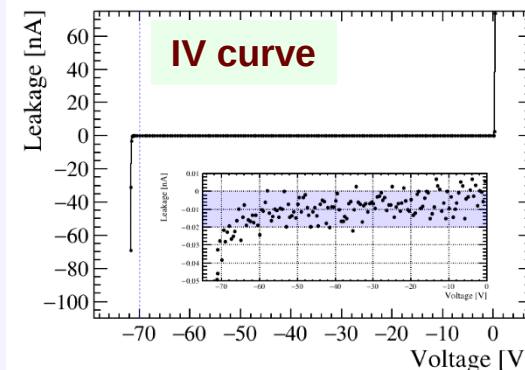


Goal

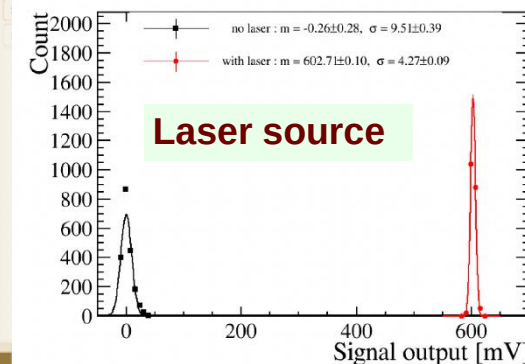
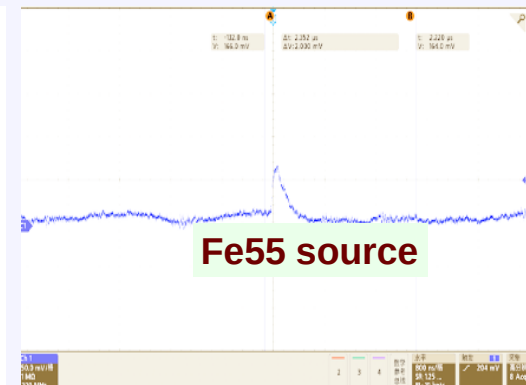
- Cost effective
- Spatial resolution $< 10\text{ }\mu\text{m}$
- Timing 3-5 ns
- Power $< 200\text{ mW/cm}^2$



Common module design for barrel & endcap; $< 1\% X_0 / \text{layer}$



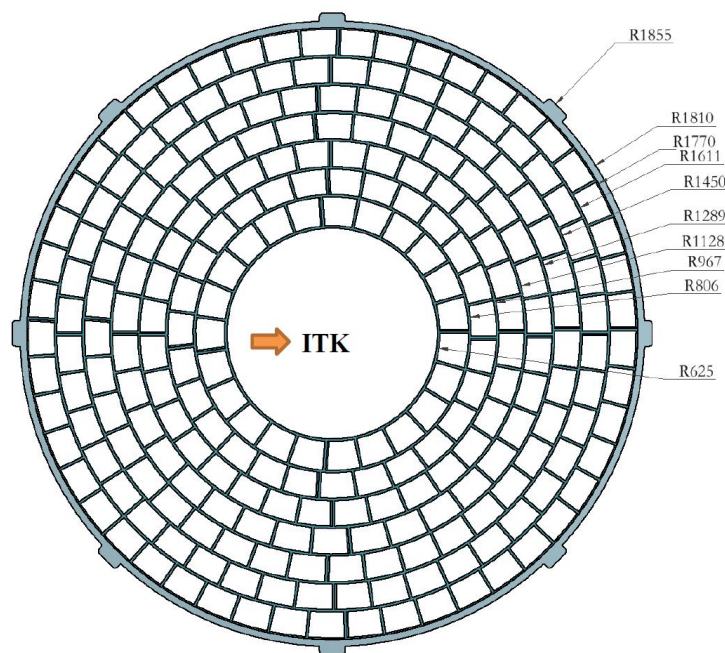
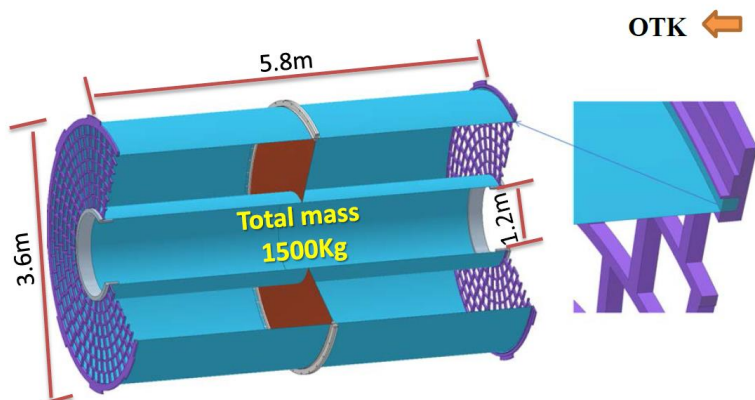
Breakdown at -70V,
to increase with high-res wafer





- ❖ Pixelated readout TPC can improve PID performance
 - Using the cluster of electrons, the full simulation study shows 3σ K/ π separation at 20GeV
 - Balanced the total power consumption and readout channels, the pad size is optimized
- ❖ Readout pad size of **$(500\mu\text{m})^2$** reduces $\text{IBF} \times \text{Gain} \sim 1 @ G=2000$, achieves $\sigma(r-\Phi) \sim 100 \mu\text{m}$.
 - Maximum $\Delta r\phi$ can be reduced to hundred $\mu\text{m} @ \text{Low } Z$ (detailed optimization of MDI)
- ❖ Plan for a test beam at DESY in November to assess the performance and validate the design

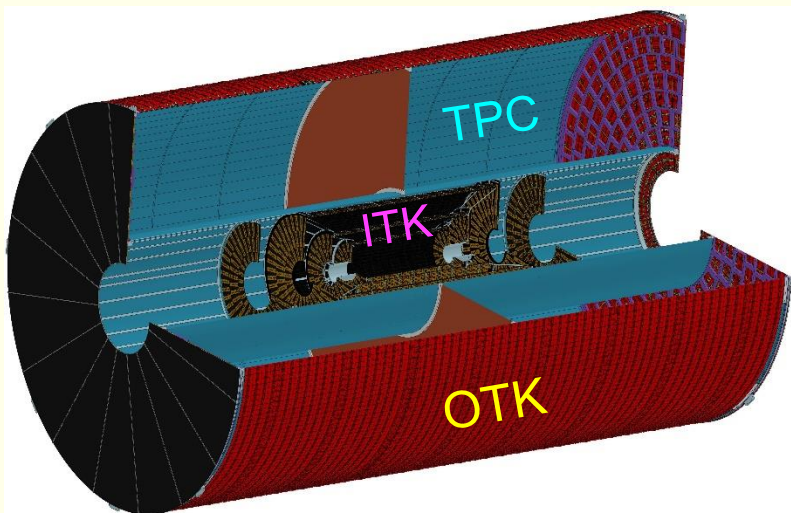
TPC detector	Key Parameters
Modules per endcap	248 modules /endcap
Module size	206mm $\times$ 224mm $\times$ 161mm
Geometry of layout	Inner: 1.2m Outer: 3.6m Length: 5.9m
Potential at cathode	- 62,000 V
Gas mixture	T2K: Ar/CF ₄ /iC ₄ H ₁₀ =95/3/2
Maximum drift time	34 μs @ 2.75m
Detector modules	Pixelated Micromegas



Detailed design of TPC detector in ref-TDR

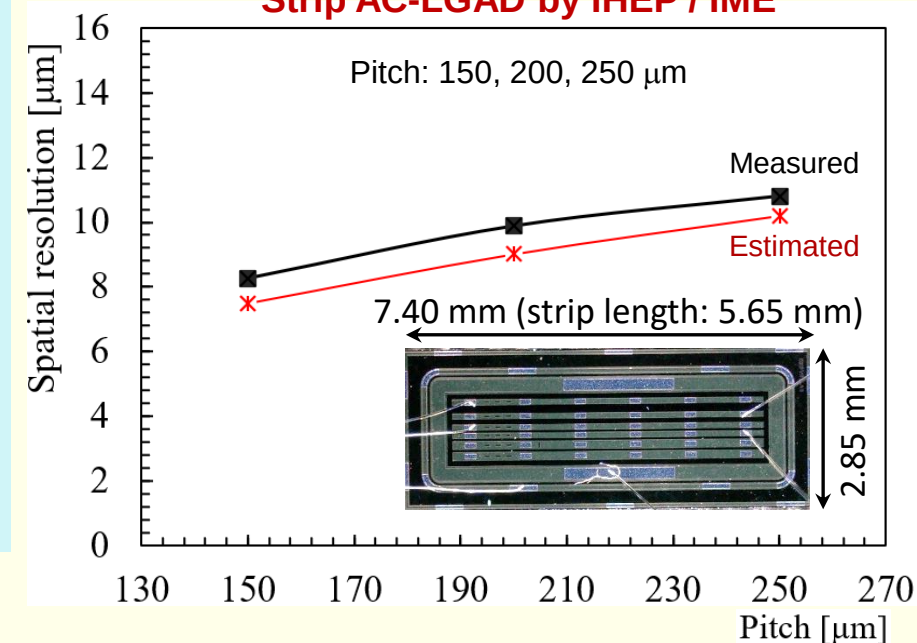


Photos TPC modules assembled for the beam test

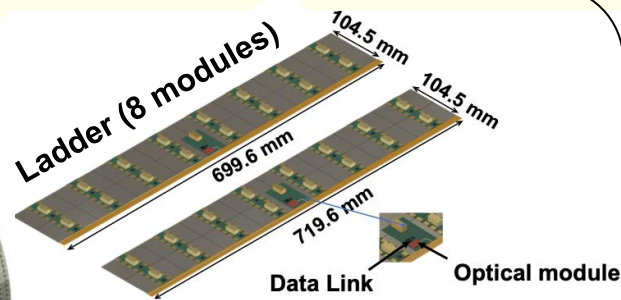
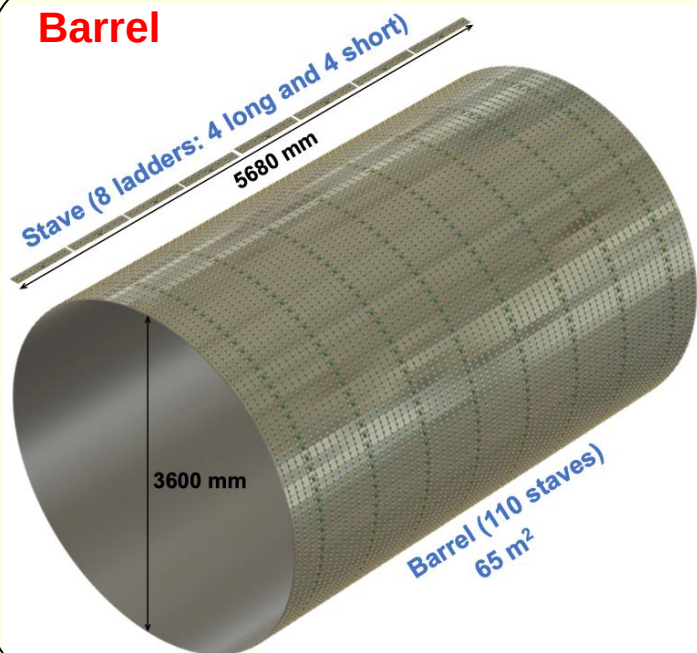


- ❑ The outer silicon tracker $\sim 85 \text{ m}^2$, the Z precision is not crucial
 $\Rightarrow$ Cost-effective SSD
- ❑ A supplemental PID at low energy
 $\Rightarrow$ LGAD ToF
- ❑ An AC-LGAD Time Tracker combines the two needs in one detector. We expect $\sigma_t \sim 50 \text{ ps}$, $\sigma_{R\Phi} \sim 10 \mu\text{m}$
- ❑ Need to validate with full size sensors

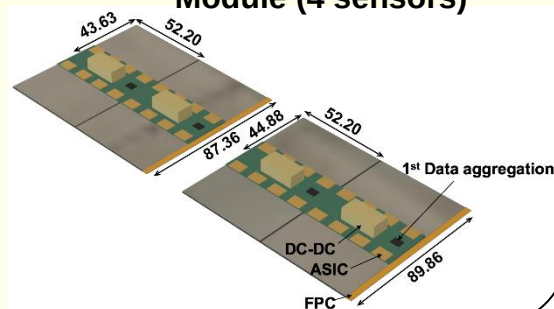
Strip AC-LGAD by IHEP / IME



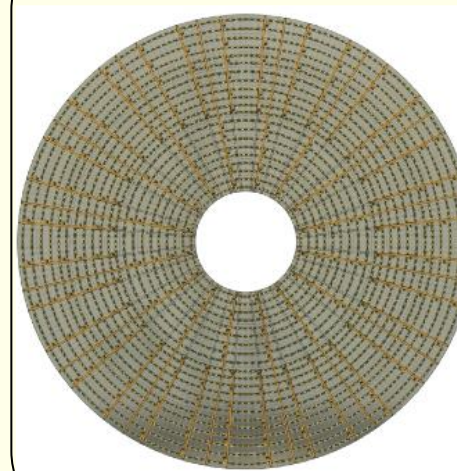
Barrel



Module (4 sensors)



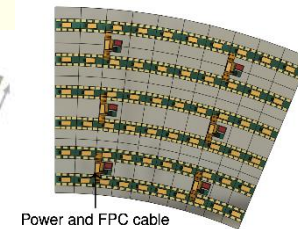
Endcap



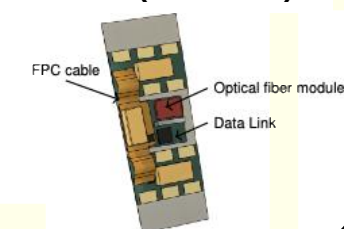
1/16 Sector

Group D:
Group C:
Group B:
Group A:

Group C Section



Module (2 sensors)

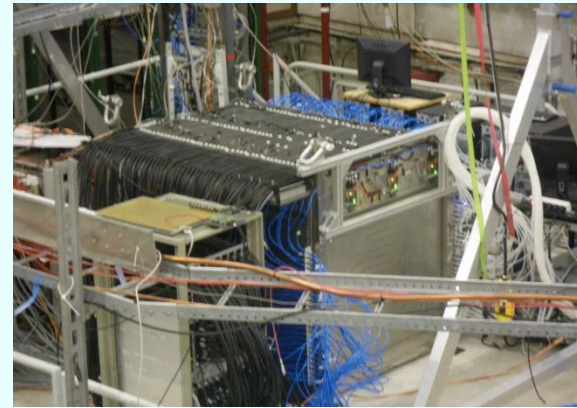




Si-W ECAL, 30 layers, 1x1 cm²



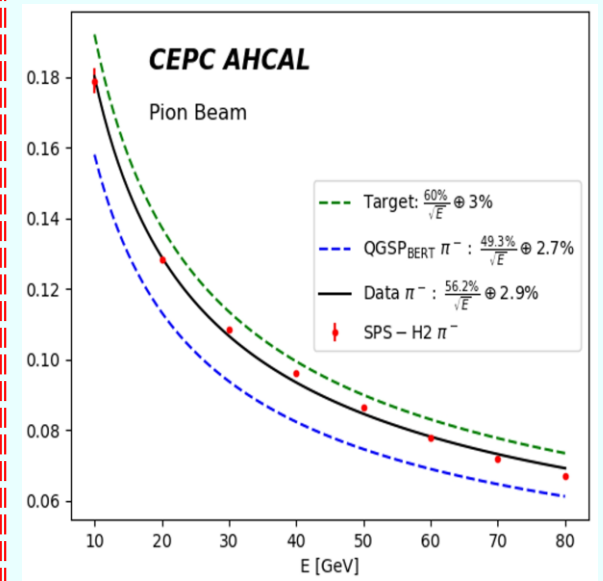
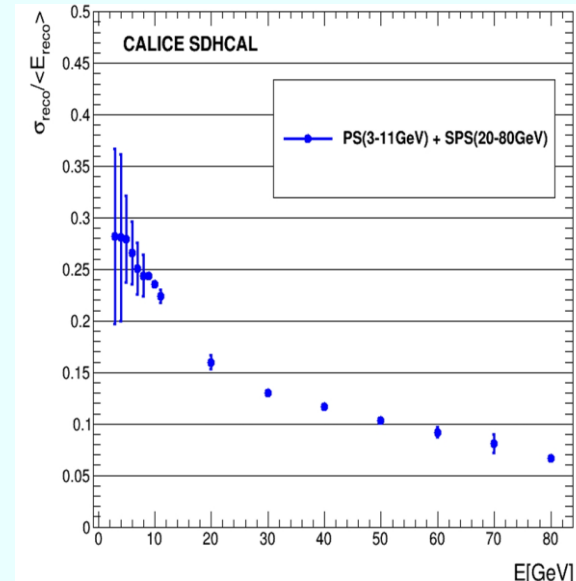
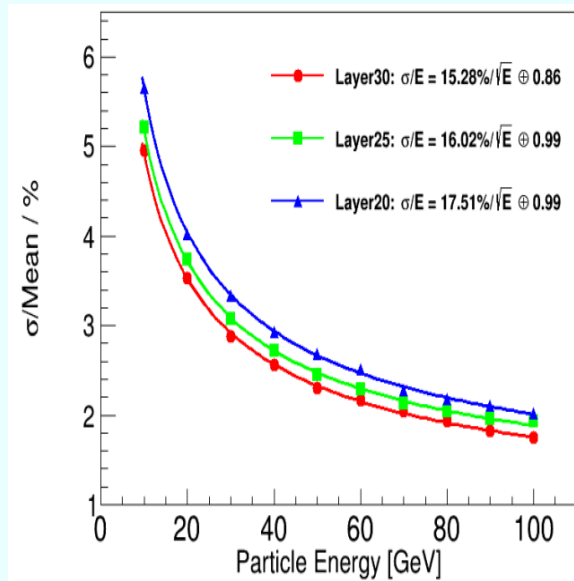
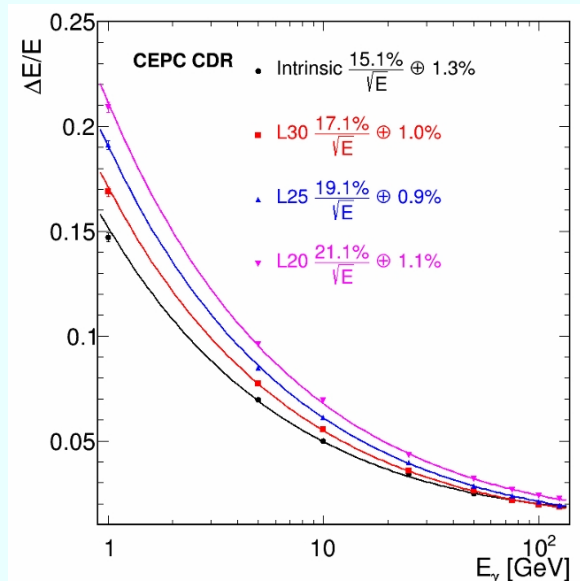
Sci-W ECAL, 32 layers, 5x5 mm²



SDHCAL, 48 layers, 1x1 cm²



AHCAL, 40 layers, 4x4 cm²





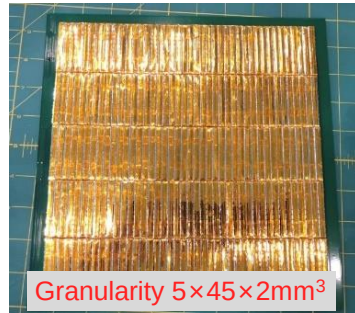
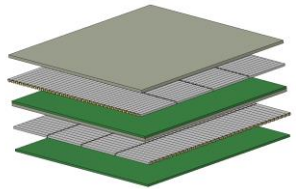
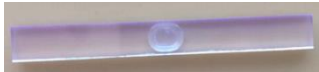
❑ ScW-ECAL: transverse 20×20 cm, 32 sampling layers

- ~6,700 channels, SPIROC2E (192 chips)

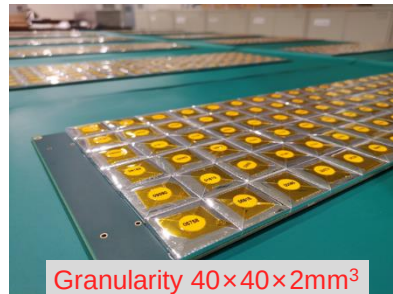
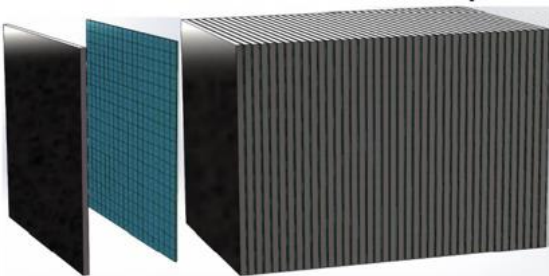
❑ AHCAL: transverse 72×72 cm, 40 sampling layers

- ~13k channels, SPIROC2E (360 chips)

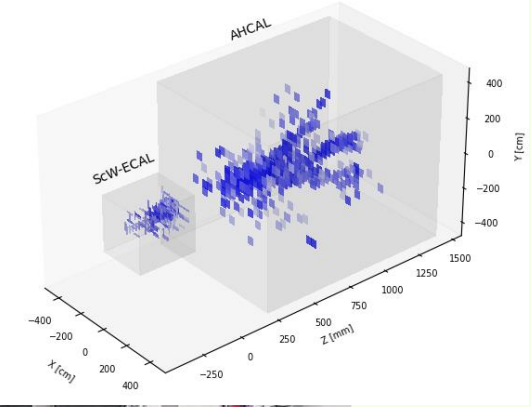
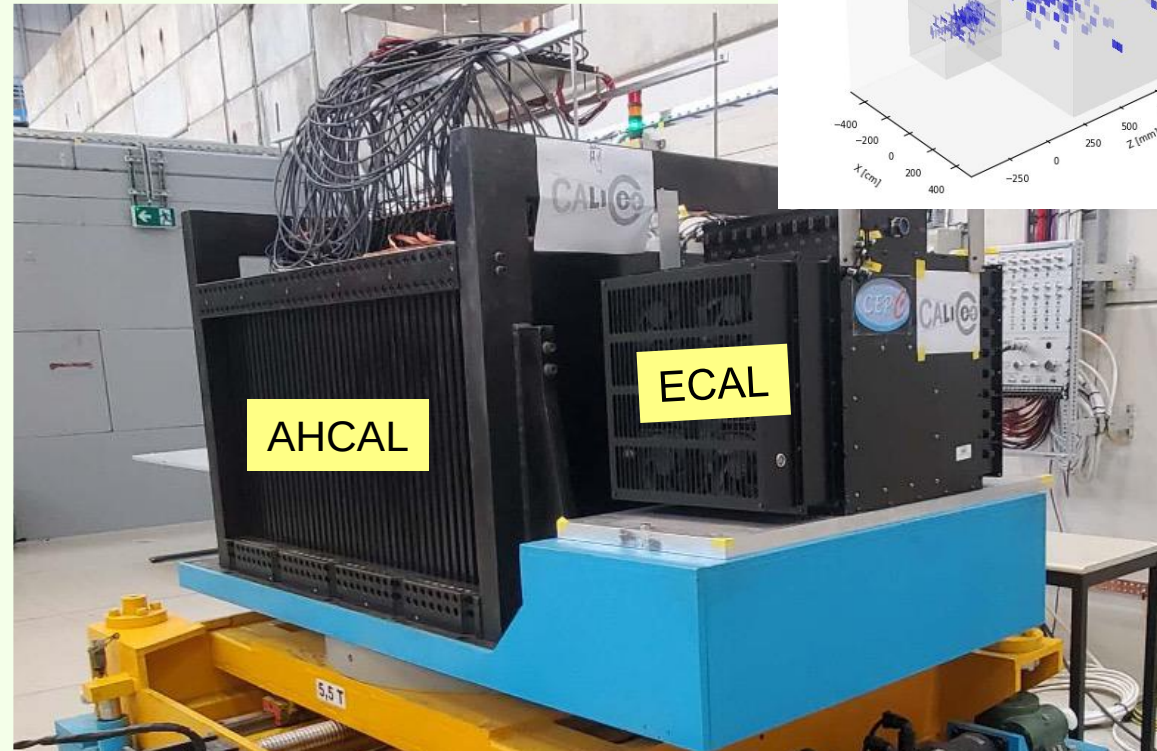
ECAL: scintillator(strip)+SiPM, CuW



HCAL: scintillator (tile)+SiPM, steel

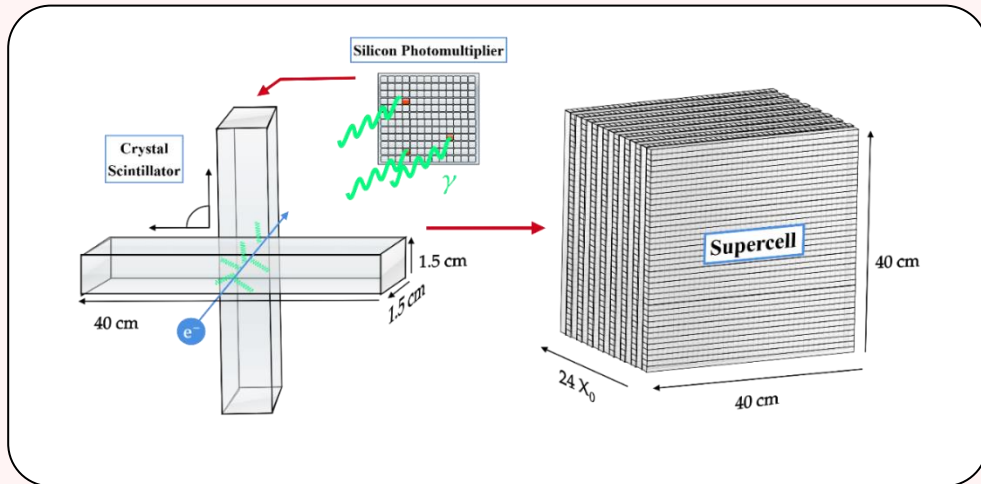


Several successful
testbeams @ CERN



Prototypes developed within **CALICE**

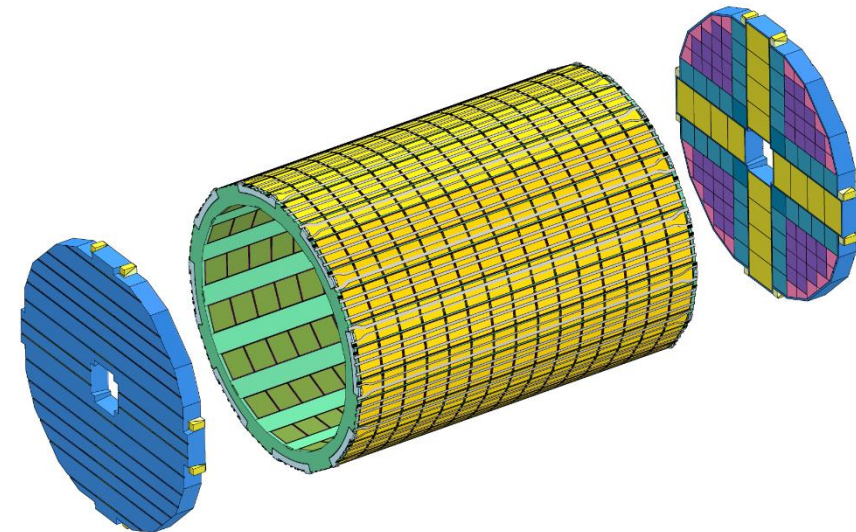
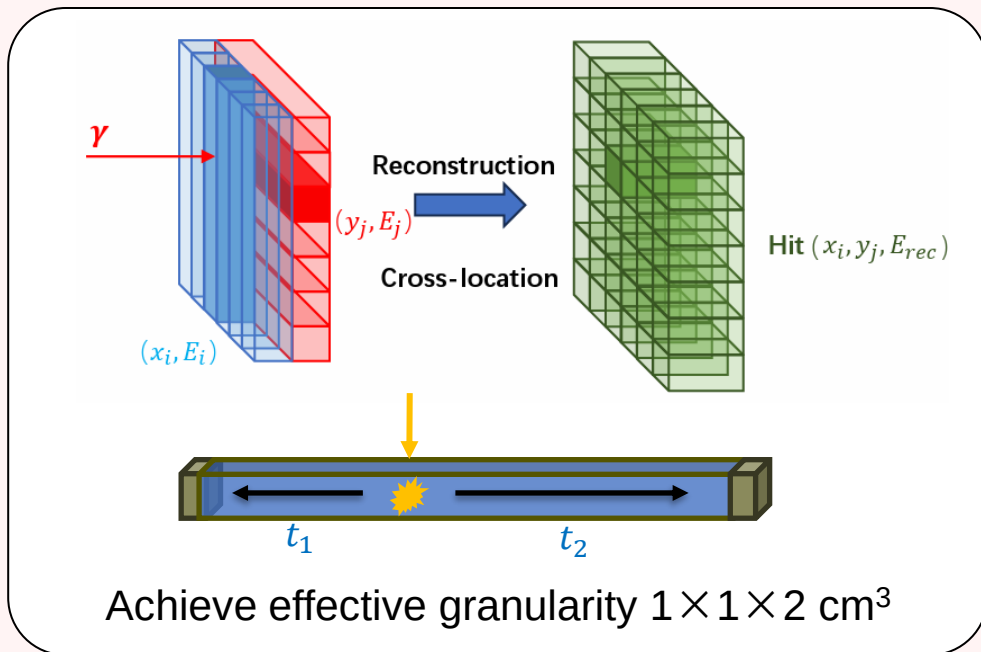
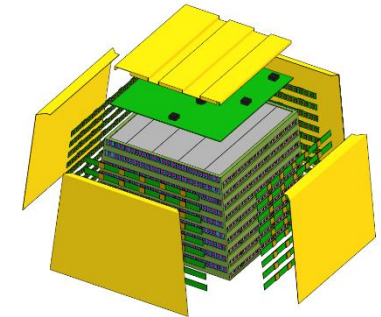
- China: IHEP, SJTU, USTC
- Japan: U. Shinshu, U. Tokyo
- France: CNRS Omega
- Israel: Weizmann Institute



- ❑ Compatible to PFA: Boson mass resolution $\text{BMR}(H \rightarrow jj) < 4\%$
- ❑ Optimal EM performance: $\sigma_E/E < 3\%/\sqrt{E}$, $\text{BMR}(H \rightarrow \gamma\gamma) \sim 0.6 \text{ GeV}$
- ❑ Save readout channels, minimize dead materials
- ❑ Challenging in pattern recognitions with multiple particles

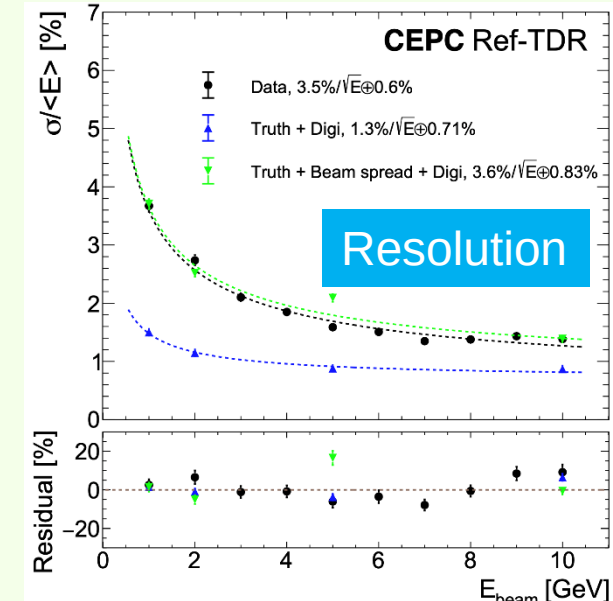
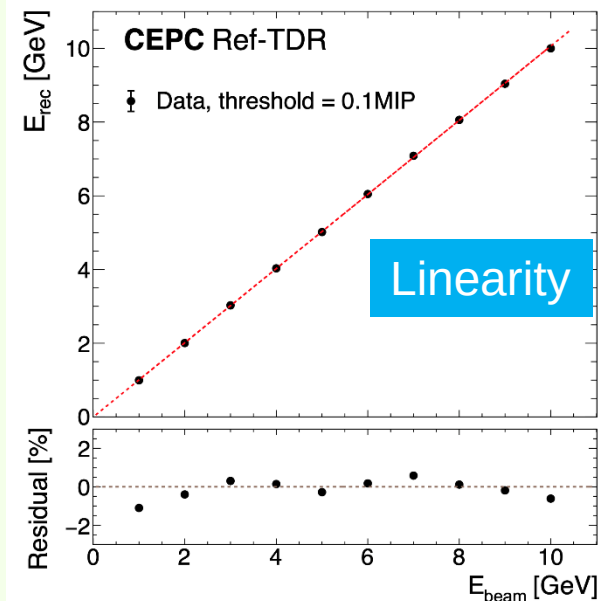
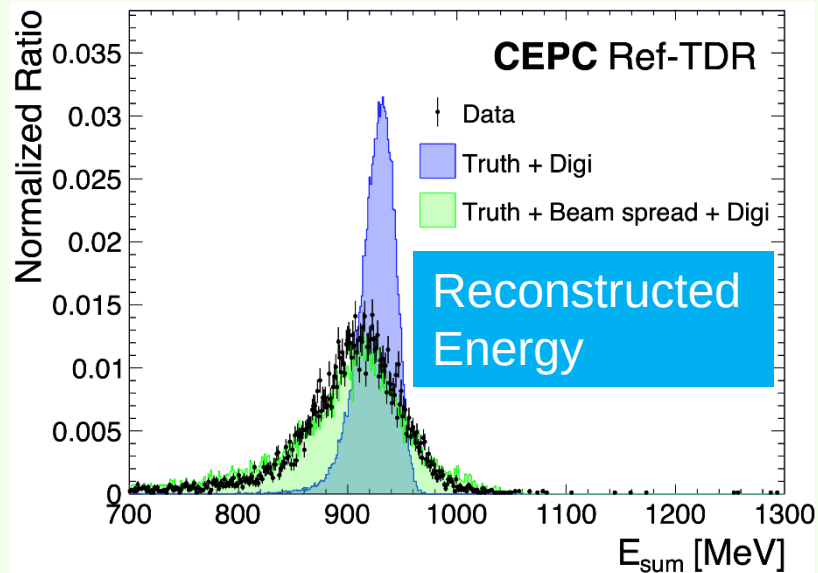
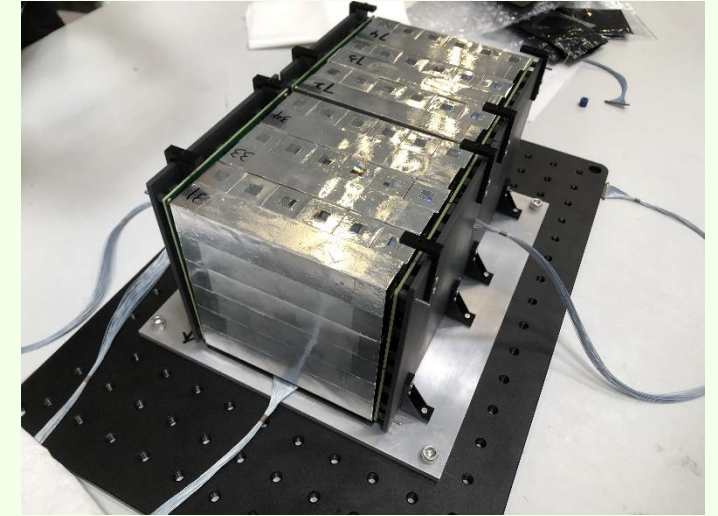
Modular Design

- 18 layers of crystals ($24 X_0$)
- Barrel: 32 towers per ring, 15 rings
- Endcap: 224 modules
- Total: 24m^3 BGO, 571k channels



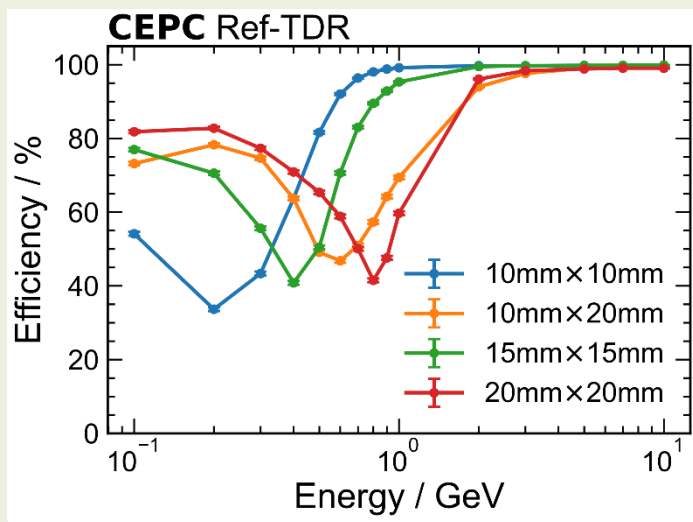


- ❖ EM-scale crystal prototype development
 - **BGO** crystal bars from SIC-CAS, (also considering **BSO**)
 - SiPM: 3×3 mm² sensitive area, 10μm pixel pitch
- ❖ Successful testbeam at CERN with 1-10 GeV electron beam
 - EM resolution (**preliminary**): $1.3\%/\sqrt{E} \oplus 0.7\%$
- ❖ To address critical issues at system level, validate design of crystal-SiPM, light-weight mechanical structure
- ❖ A full-scale prototype will be constructed

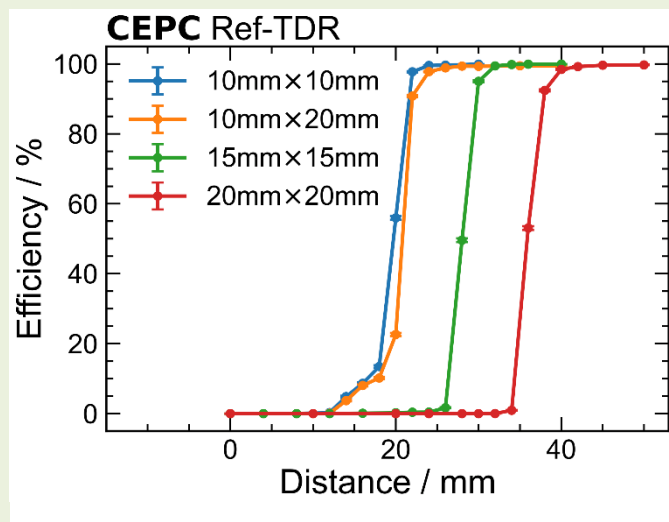




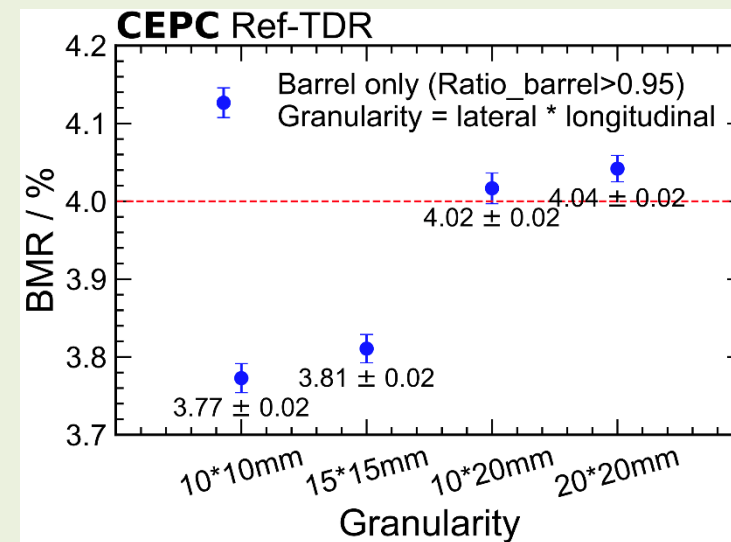
- ❖ ECAL granularity: balance of performance and readout
 - 10×10mm, 10×20mm, 15×15 mm and 20×20mm
- ❖ Figures of merit
 - Single photon reconstruction, separation power and jet performance



Major impact from ECAL longitudinal segmentation



Separation efficiency dominated by ECAL transverse granularity



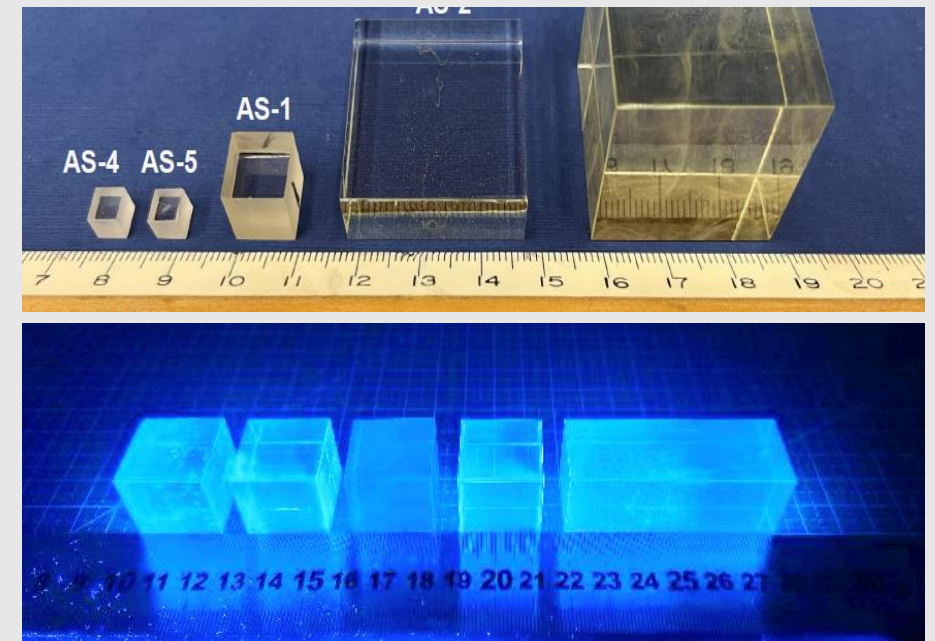
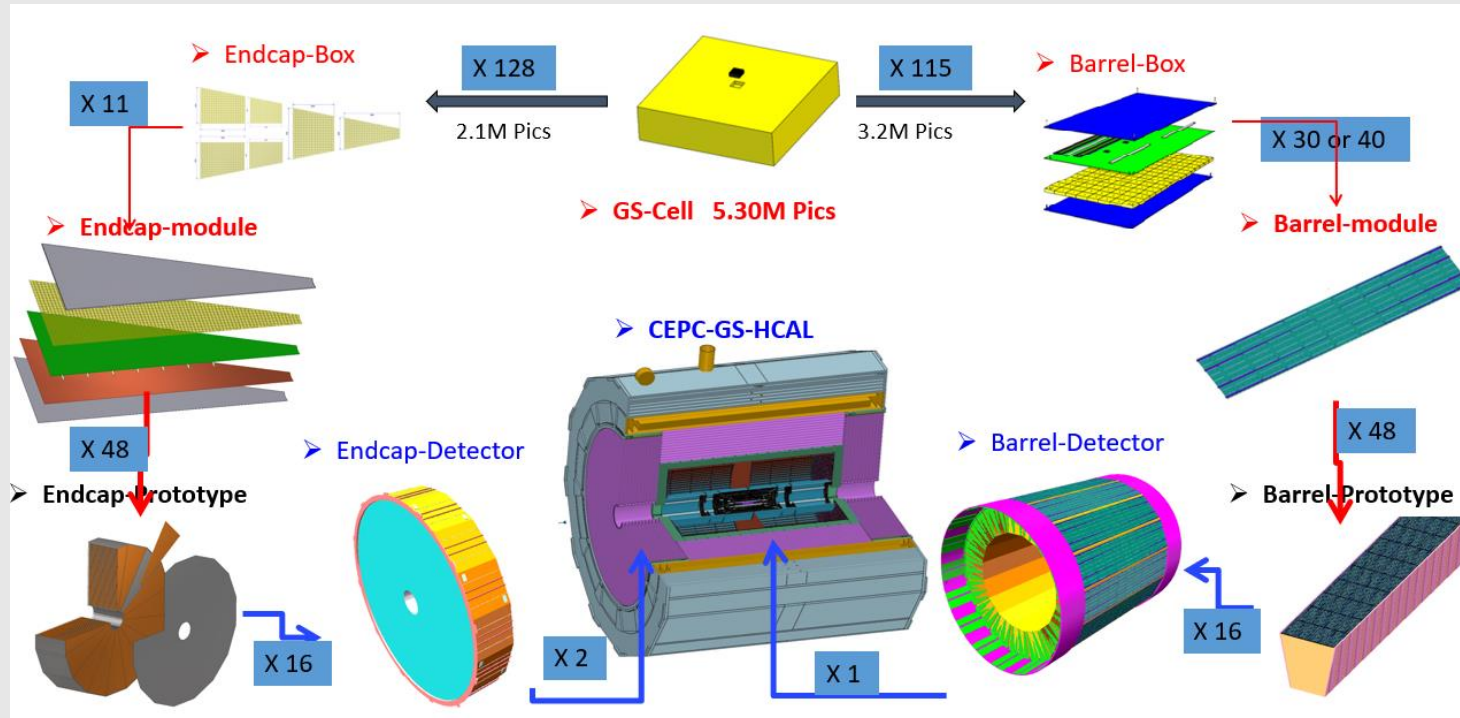
10x10mm and 15x15mm can meet physics requirement of BMR <4%

Conclusion: ECAL granularity of **15×15mm²** selected for ECAL



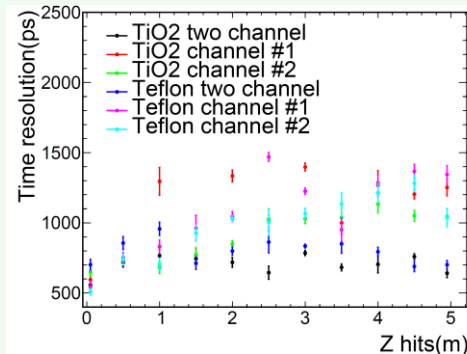
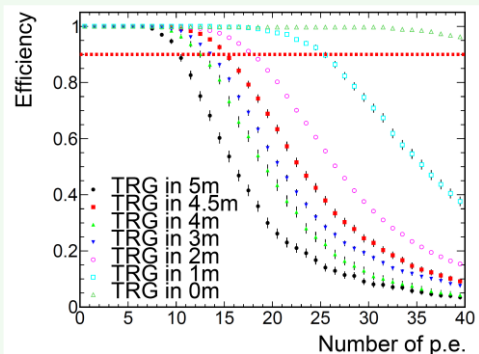
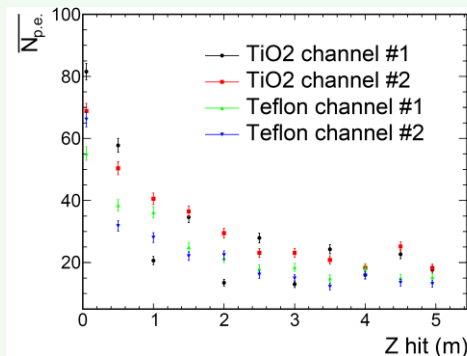
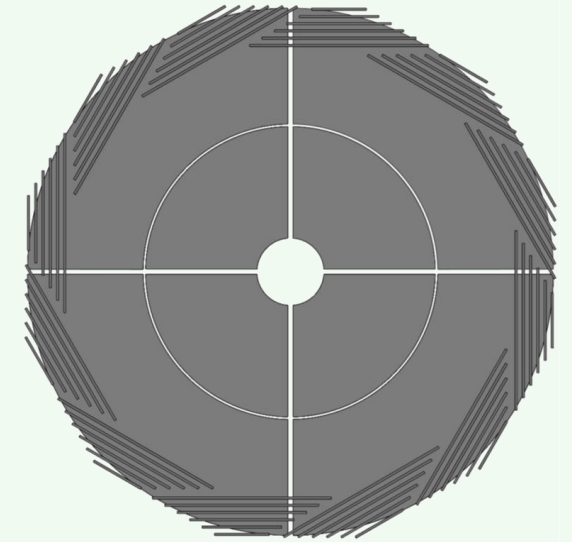
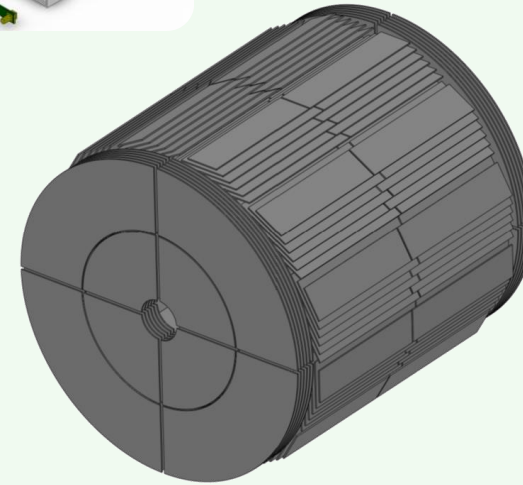
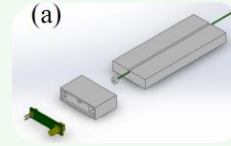
- ❑ To replace plastic scintillator with **high density**, low cost glass scintillator for better hadronic energy resolution and BMR
- ❑ The Scintillation Glass collaboration continues to progress on the quest for better GS, and technique for mass production
- ❑ To produce a full-scale GS-HCAL prototype with integrated electronics for beam test

Key parameters	GFO glass	BGO	DSB Glass
Density (g/cm ³)	6.0	7.13	4.2
Melting point (°C)	1250	1050	1550
Radiation Length (cm)	1.59	1.12	2.62
Molière radius (cm)	2.49	2.23	3.33
Nuclear interaction length (cm)	24.2	22.7	31.8
Z _{eff}	56.6	71.5	49.7
dE/dX (MeV/cm)	8.0	8.99	5.9
Emission peak (nm)	400	480	430
Refractive index	1.74	2.15	
Light yield (ph/MeV)	~ 1500	7500	2500
Energy resolution (% @662keV)	~ 23	9.5	
Scintillation decay time (ns)	~ 60 and 500	60, 300	90, 400

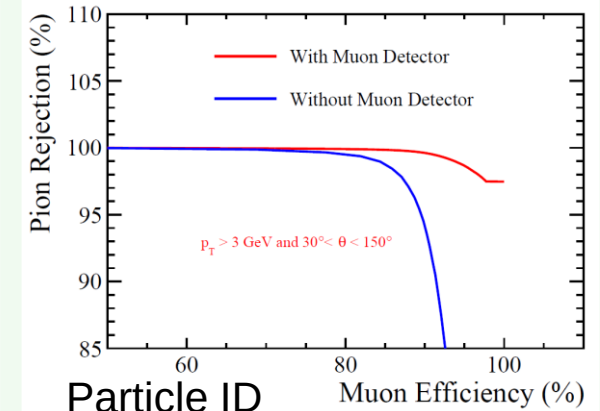
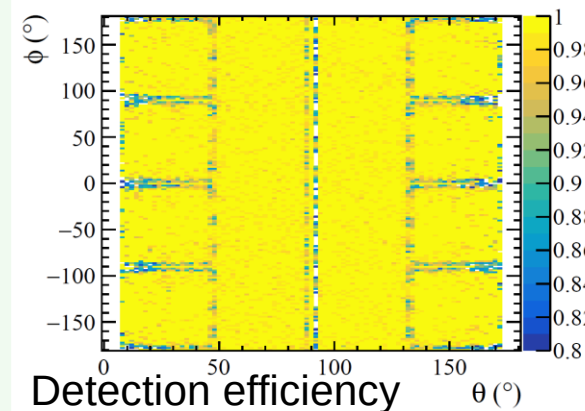


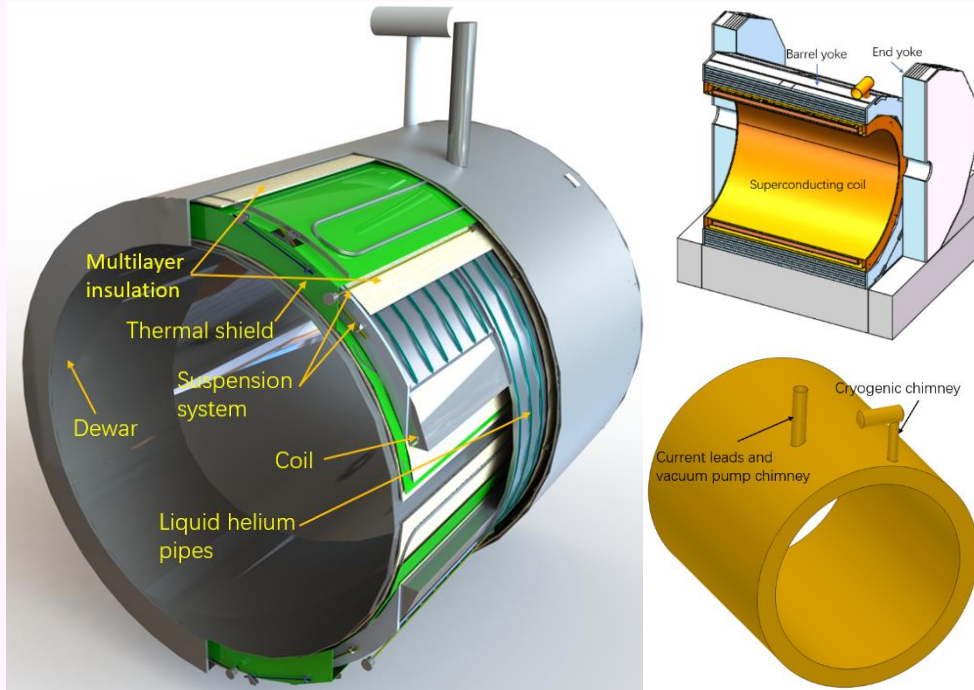


- Use extruded plastic scintillator (PS) technology, provide Muon ID $> 95\%$, and pion fake rate $< 1\%$
- Strip/channel structure: PS bar + WLS fiber + SiPM
- Solid angle coverage: $0.98 \times 4\pi$, total detection area $\sim 4,800 \text{ m}^2$, $\sim 43\text{k}$ channels
- Prototype of 5m channel: $\epsilon > 95\%$, $\sigma_T \sim 1\text{ns}$



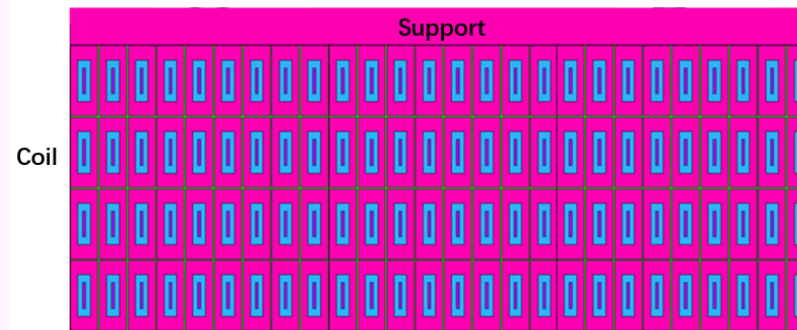
Simulation and performance





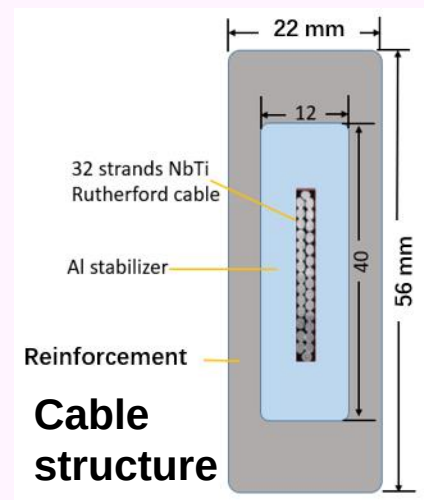
- ❑ Design of the overall structure and the supporting systems
- ❑ Production of short samples (5m) of Al-stabilized NbTi Rutherford cable

Central B field	3 T
Coil inner diameter	7300 mm
Coil outer diameter	7916 mm
Coil length	8150 mm
Operating current	17 kA
Coil module gap	50 mm
Inductance	11 H
Stored energy	1.54 GJ

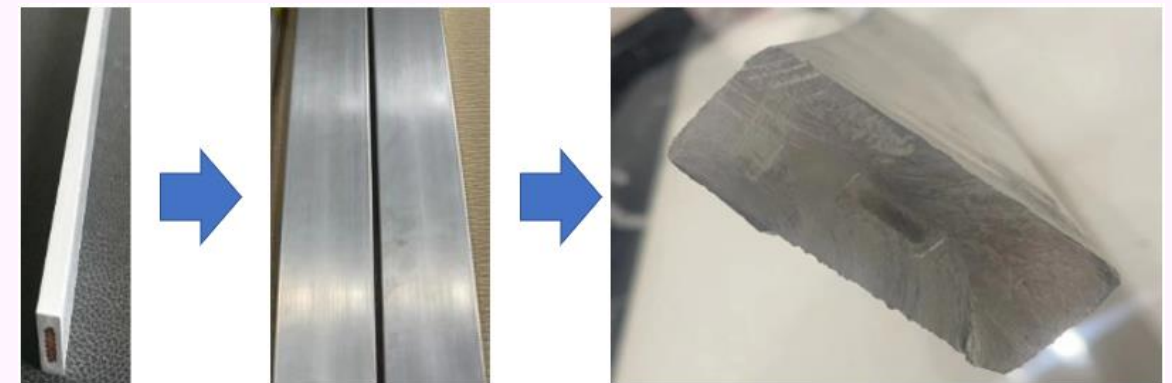


Coil structure

Inner diameter	7070 mm
Outer diameter	8470 mm
Thickness	700 mm
Length	9050 mm
Cold mass	185 tons
Yoke weight	2960 tons
Magnet weight	290 tons



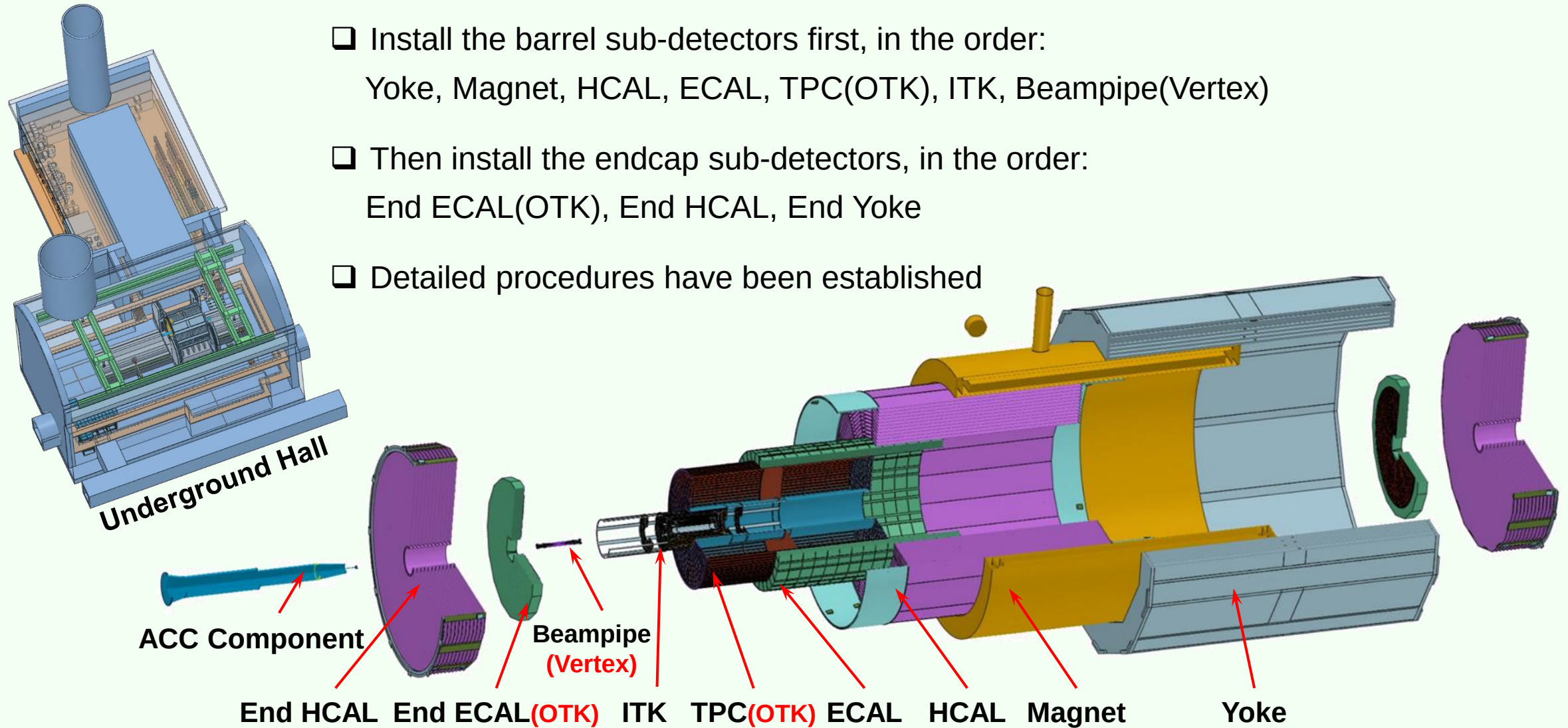
Cable structure

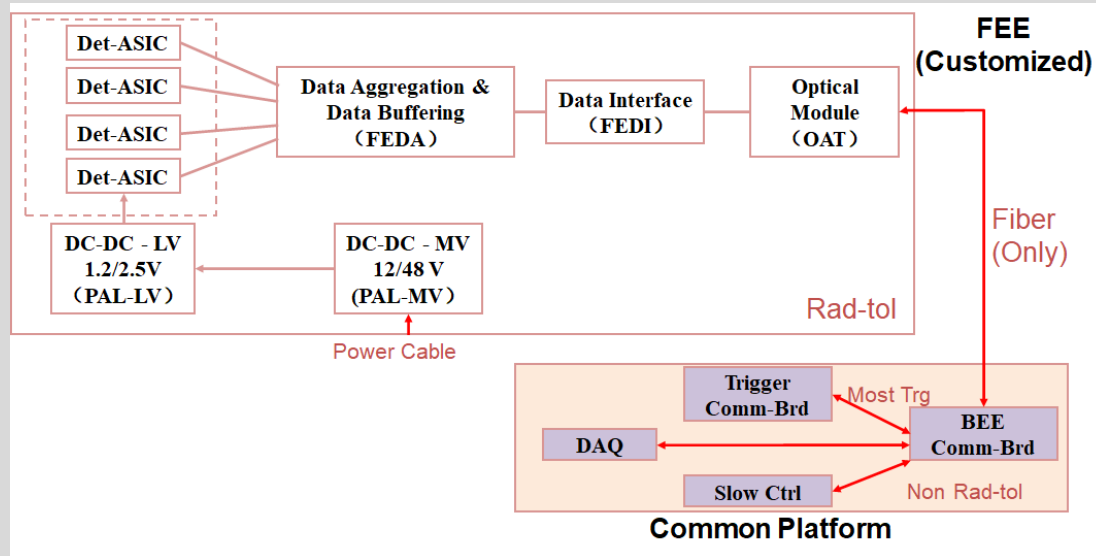


The 2nd co-extrusion process

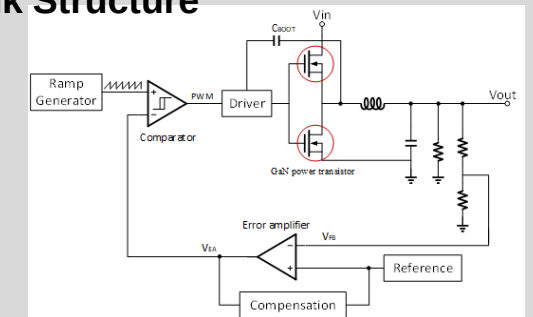
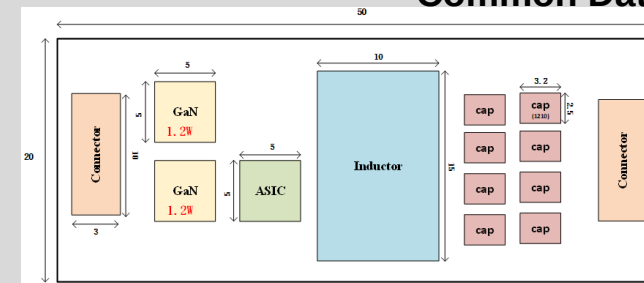
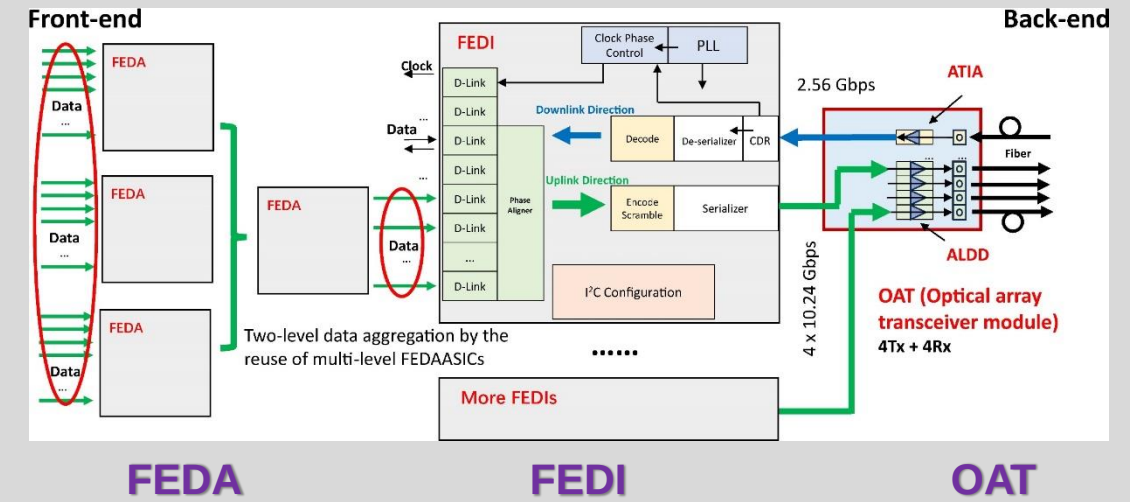


- ❑ Install the barrel sub-detectors first, in the order:
Yoke, Magnet, HCAL, ECAL, TPC(OTK), ITK, Beampipe(Vertex)
- ❑ Then install the endcap sub-detectors, in the order:
End ECAL(OTK), End HCAL, End Yoke
- ❑ Detailed procedures have been established

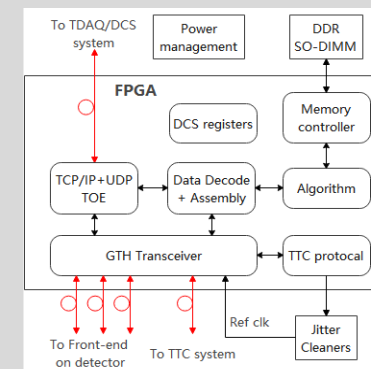


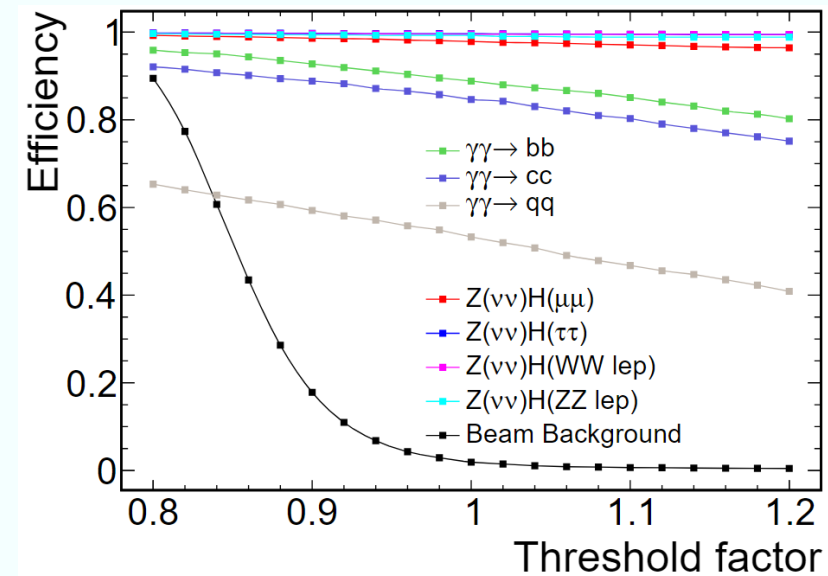
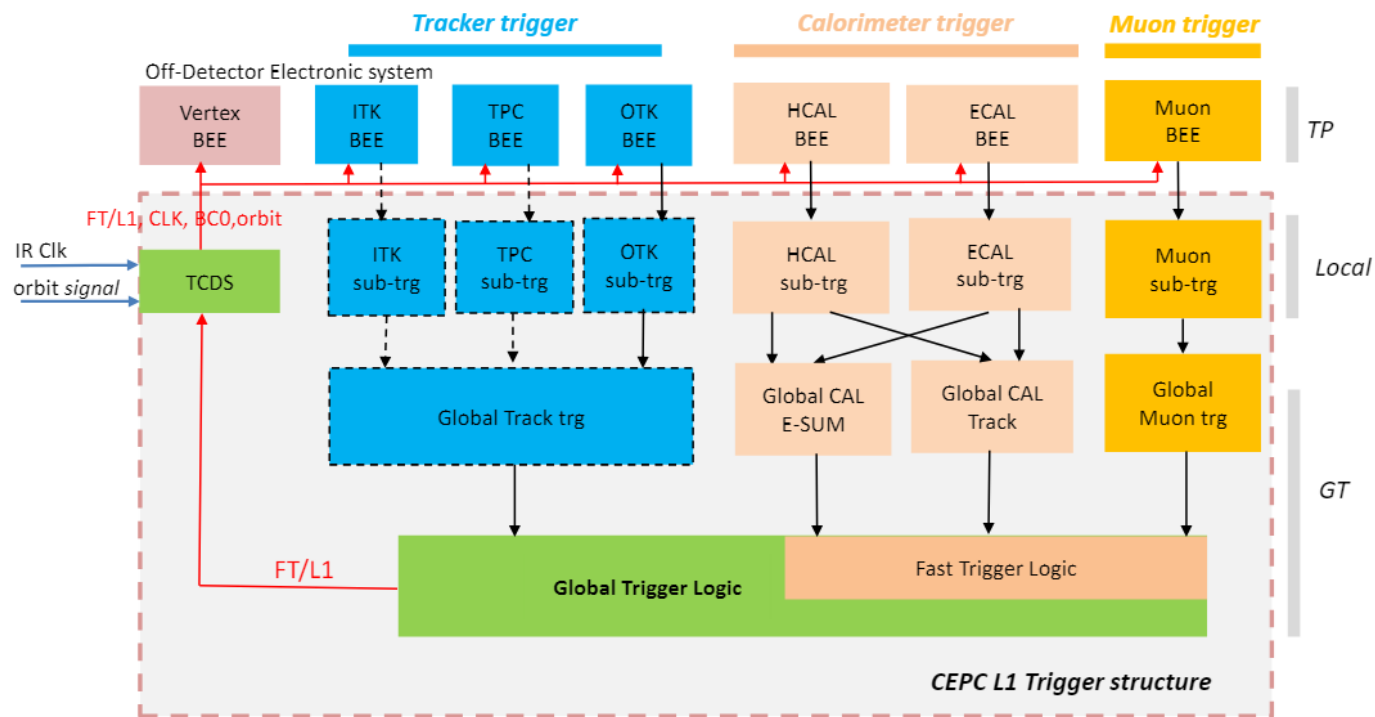


- ❖ Baseline: Triggerless FE readout & BE trigger
- ❖ Maximizing the common design:
 - Common FEE blocks, including data aggregation, transmission, optical, powering
 - Common BEE & Common Trigger: configurable for individual subsystems.



Common Powering Module (PAL)



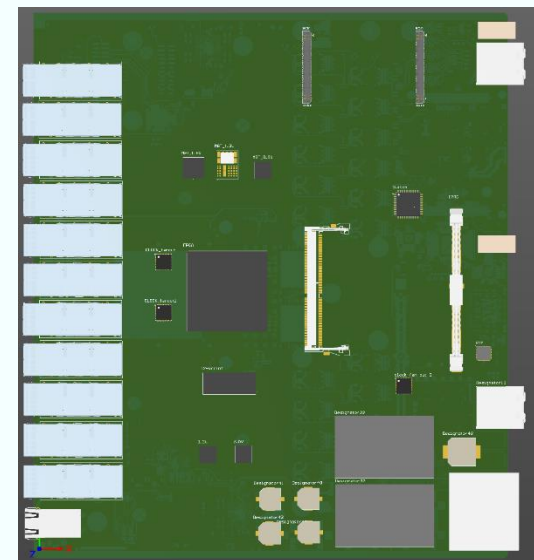


- ❖ Hardware trigger at BE + HLT software trigger
- ❖ L1 trigger on calorimeter, muon, and trackers
- ❖ Will explore a full software trigger with GPUs

L1 trigger board

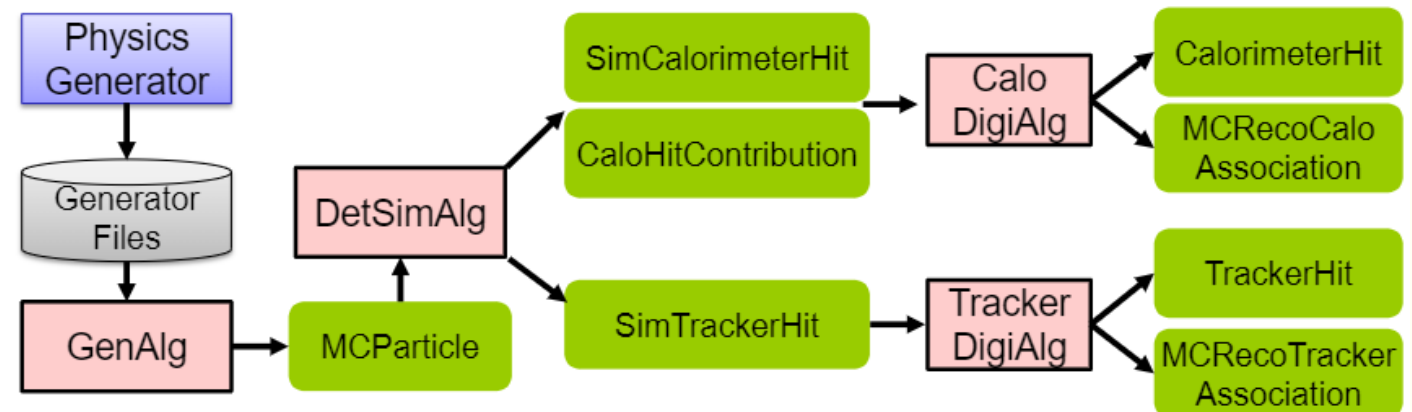
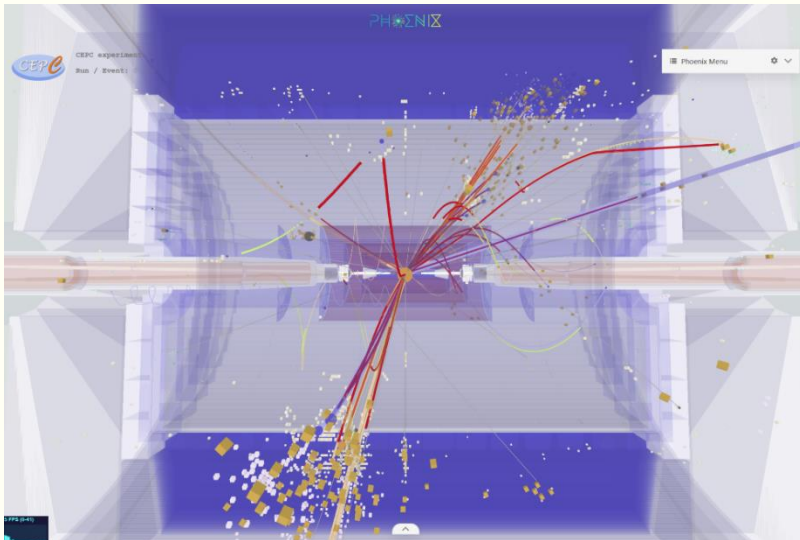
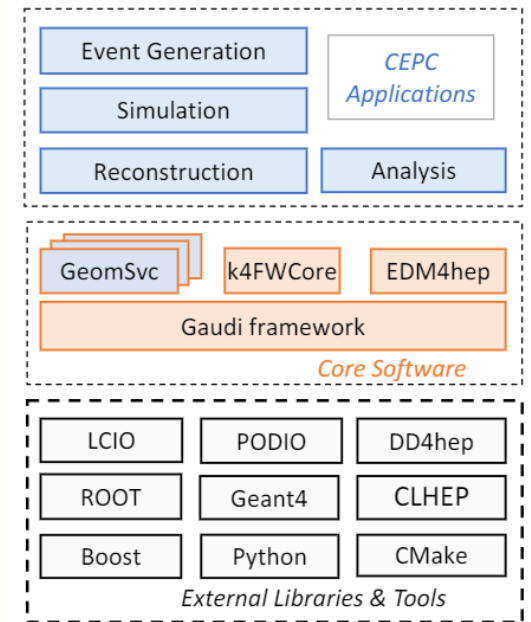
36-48 channels
×10-25Gbps
Optical interface

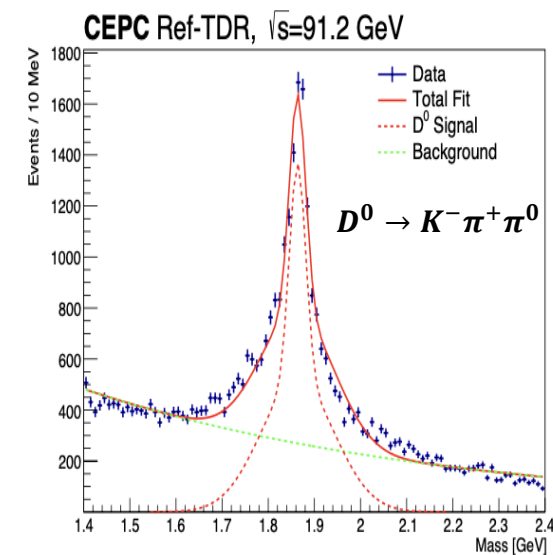
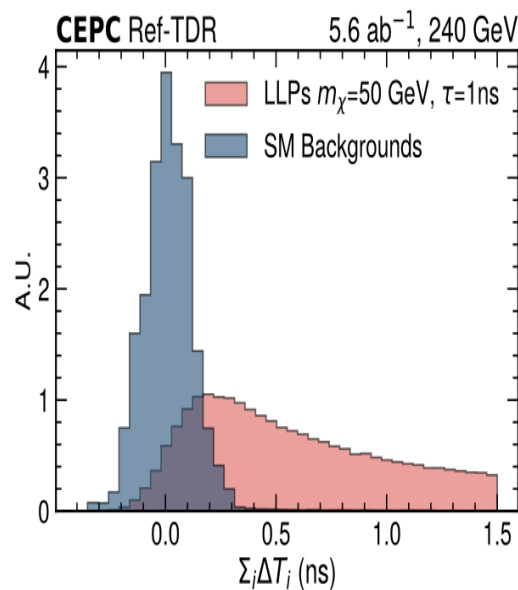
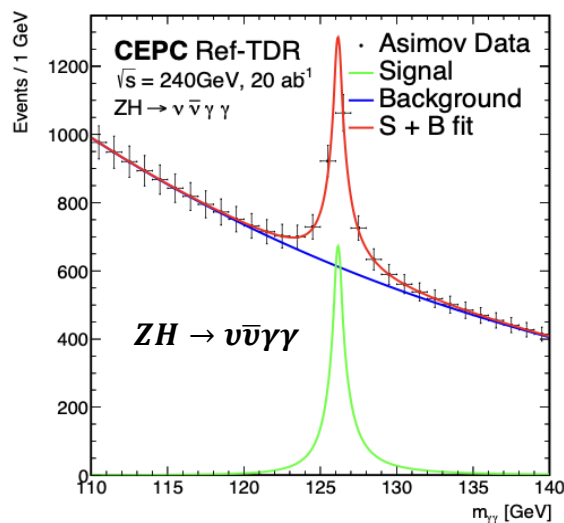
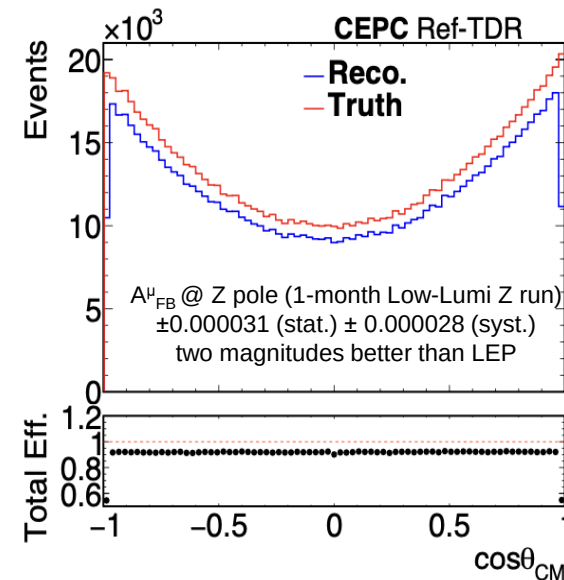
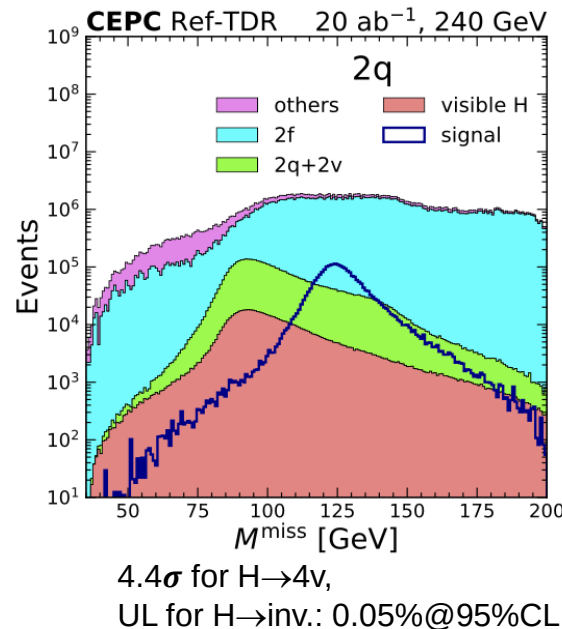
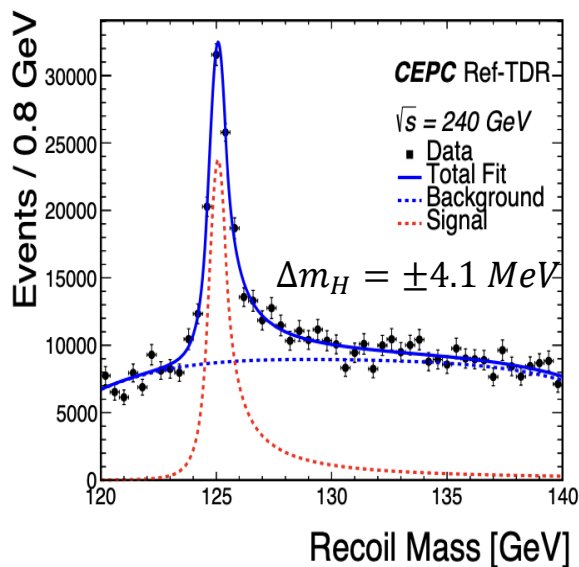
Xilinx Virtex FPGA

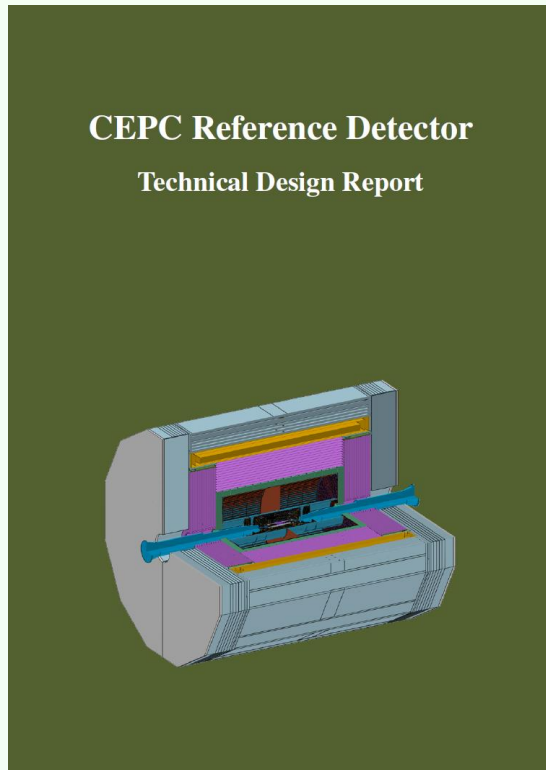




- ❑ **CEPCSW** bases on the **Gaudi** framework and **Key4hep** stack, using well-known HEP tools while creating new solutions to meet the experiment's needs
- ❑ The **Geant4**-based simulation has been used to generate Monte Carlo data, which has then been reconstructed to validate **detector performance** and assess the **physics potential**
- ❑ Continuous **refinement** of the software stack is crucial for ensuring optimal performance and reliability
- ❑ Incorporating **emerging technologies** such as AI and machine learning will be instrumental in overcoming critical challenges faced by the experiment







Version 0.4.1 of Jun 14, 2025
~ 650 pages

- 1) Introduction
- 2) Concept of CEPC Reference Detector
- 3) MDI and Luminosity Measurement
- 4) Vertex Detector
- 5) Silicon Trackers
- 6) Pixelated Time Projection Chamber
- 7) Electromagnetic Calorimeter
- 8) Hadronic Calorimeter
- 9) Muon Detector
- 10) Detector Magnet System
- 11) Readout Electronics
- 12) Trigger and Data Acquisition
- 13) Offline Software and Computing
- 14) Mechanics and Integration
- 15) Detector and Physics Performance
- 16) Timeline and Plans



The CEPC International Detector Committee Meeting in 2024

Oct 21-23, IHEP



THE CEPC INTERNATIONAL DETECTOR COMMITTEE MEETING IN 2025

APR 14-16, IHEP



Ivan Villa Alvarez	IFCA	Bob Kowalewski	U. Victoria
Daniela Bortoletto (Chair)	U. Oxford	Roman Poeschl	IJCLab
Jim Brau	U. Oregon	Burkhard Schmidt	CERN
Anna Colaleo	INFN/Bari	Maxim Titov	CEA Saclay
Paul Colas	CEA Saclay	Tommaso Tabarelli de Fatis	INFN/Milano-Bicocca
Cristinel Diaconu	CPPM	Roberto Tenchini	INFN/Pisa
Frank Gaede	DESY	Christophe De La Taille	OMEGA/CNRS
Colin Gay	UBC	Hitoshi Yamamoto	Tohoku U.
Liang Han	USTC	Akira Yamamoto	KEK
Gregor Kramberger	IJS		

- ❑ The IDRC (International Detector Review Committee) had two reviews in October 2024 and April 2025
- ❑ The committee provided very helpful and detailed comments and recommendations.
- ❑ In general there is no showstopper.



- ❑ The Ref-TDR preparation process provided a unique opportunity for the CEPC study group to expand collaboration.
 - Domestic research institutes ~ **50**, international institutes ~ **40**
 - We hope that the number will continue to increase, especially during the Ref-TDR authorship sign-ups. It will help future R&D and lead to formation of the two experiment collaborations.
- ❑ Active member of the ECFA DRD program

Sub-system	DRD	Sub-system	DRD	Sub-system	DRD
Pixel Vertex Detector	3	Electromagnetic Calorimeter	6	Super Conducting Magnet	
Inner Silicon Tracker	3	Hadron Calorimeter	4, 6	Mechanical and Integration	8
Outer Silicon Tracker	3	Machine Detector Interface	8	General Electronics	(7)
Gas Tracker (TPC / DC)	1	Luminosity Calorimeter		Trigger and DAQ	(7)
Muon Detector	1 (RPC)	Fast Luminosity Monitor	3	Offline Software	

- ❑ Participating in the European Strategy for Particle Physics process ([CEPC input](#)).

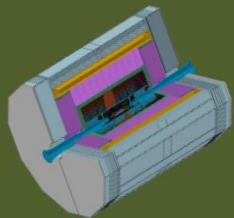


Date	Actions and/or Expectations
Jan 1, 2024	Start the ref-TDR process by comparing different technologies
Jul 1, 2024	Baseline technologies are chosen; start to write TDR and address key issues
Aug 7, 2024	Report to the IDRC chair Prof Daniela Bortoletto
Oct 21-23, 2024	Review of ref-TDR progress by the IDRC
Oct 23-30, 2024	Discuss ref-TDR at the CEPC workshop, report progresses to the CEPC IAC
January 2025	The first draft of the ref-TDR is ready for internal reviews
Apr 14-16 2025	Review of ref-TDR progress by the IDRC
Jun 16-19, 2025	Discuss at the CEPC Barcelona workshop
TBD	Further iteration and review
2nd half of 2025	Publication of the ref-TDR
Nov 6-10, 2025	Report at the CEPC Guangzhou workshop

We welcome more teams to join the quest, help editing, sign up authorship to show support

Thank you for supporting CEPC!

CEPC Reference Detector
Technical Design Report



06/16/2025

<https://indico.ihep.ac.cn/event/25300>



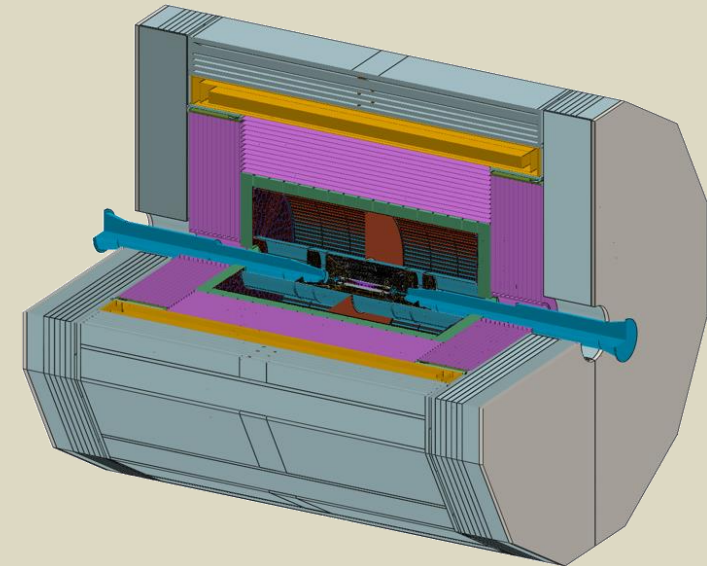
Backup Slides



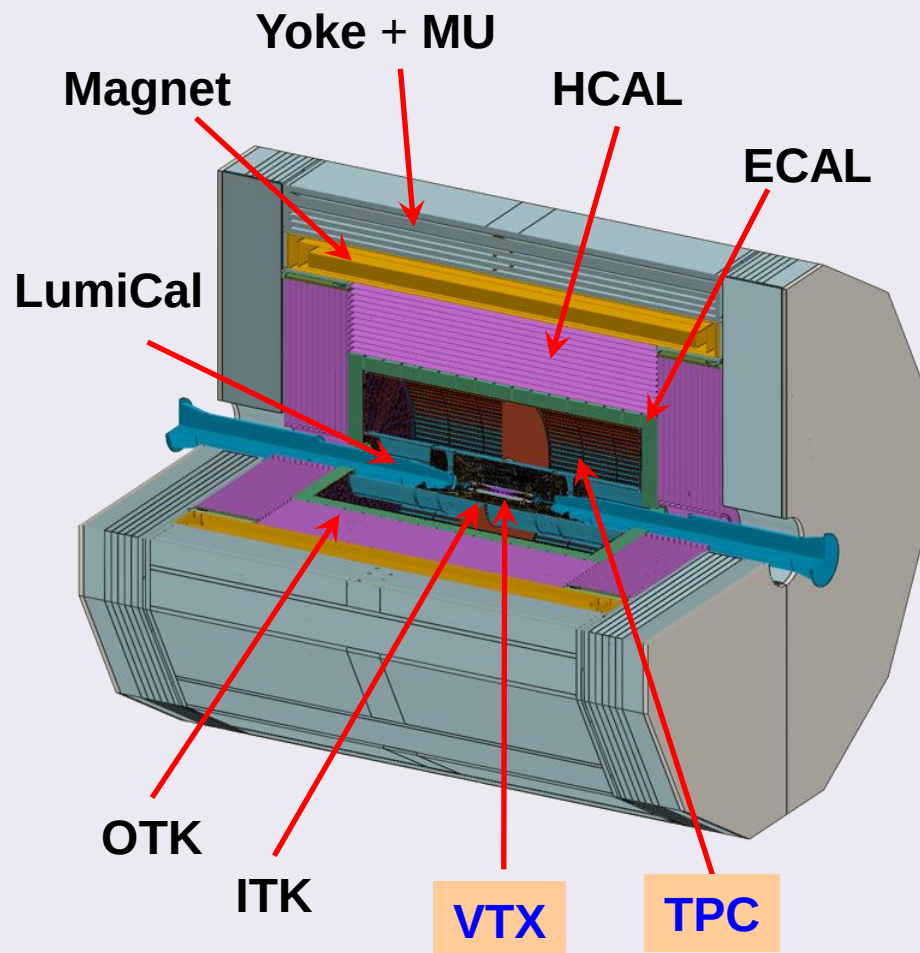
System	Technologies	
	Baseline	Backup / Comparison
Beam pipe	Φ20 mm	
LumiCal	SiTrk + Crystal	
Vertex	CMOS + Stitching	CMOS Si Pixel
Tracker	CMOS Si Pixel ITK	SSD + RO Chip, CMOS SSD
	Pixelated TPC	PID Drift Chamber
	AC-LGAD OTK	SSD / SPD OTK
		LGAD ToF
ECAL	4D Crystal Bar	Stereo Crystal Bar, GS+SiPM, PS+SiPM+W, SiDet+W
HCAL	GS+SiPM+Fe	PS+SiPM+Fe, RPC+Fe
Magnet	LTS	HTS
Muon	PS bar+SiPM	RPC
TDAQ	Conventional	Software Trigger
BE electr.	Common	Independent

- ❑ The CEPC study group started to compare different technologies and chose the baseline technologies were chosen in the first half year of 2024
- ❑ Multiple factors were considered in the process: performance, cost, R&D efforts, technology maturity, ...

Radius



- ❑ We will **continue pursuing better technologies** for the two final detectors at CEPC



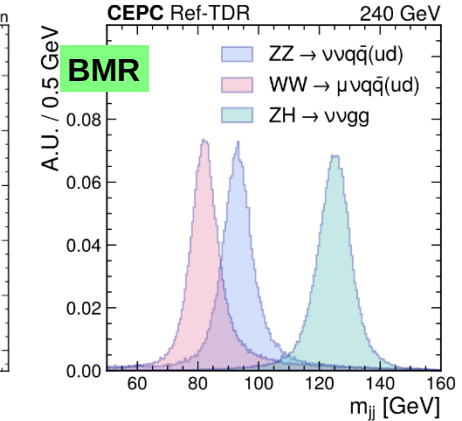
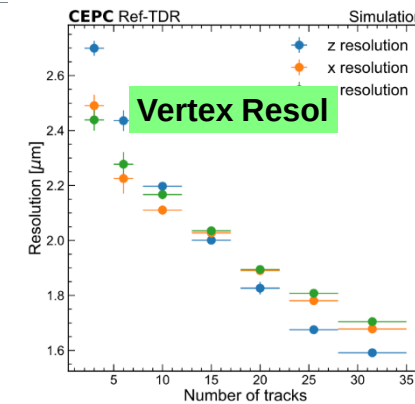
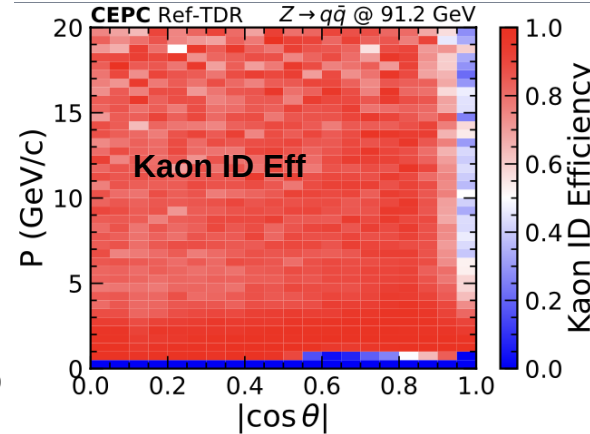
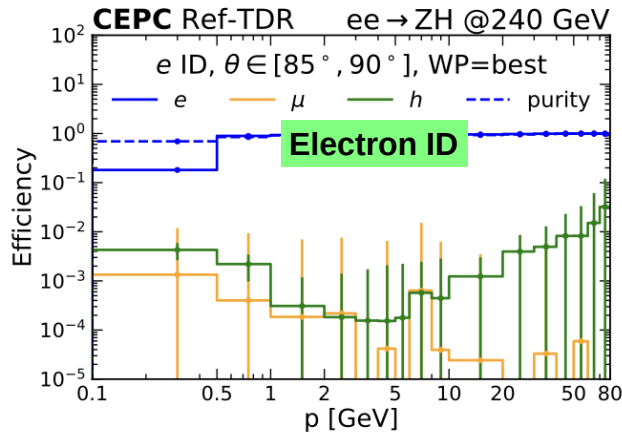
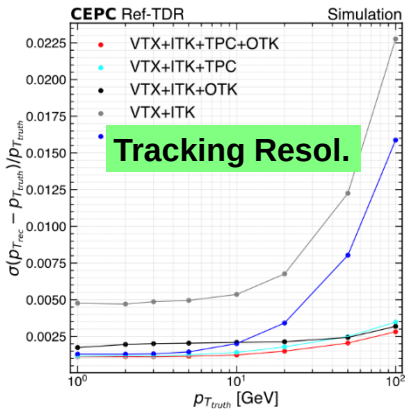
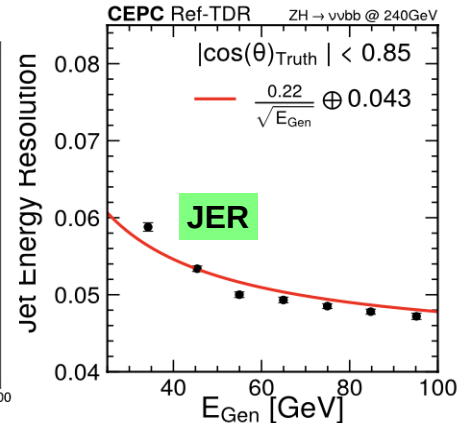
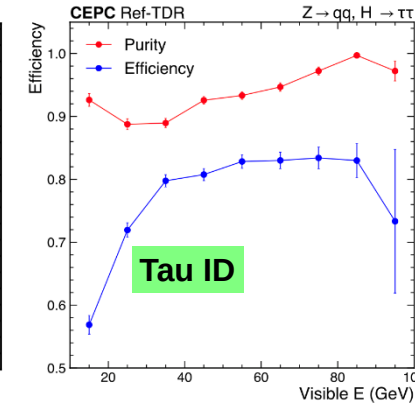
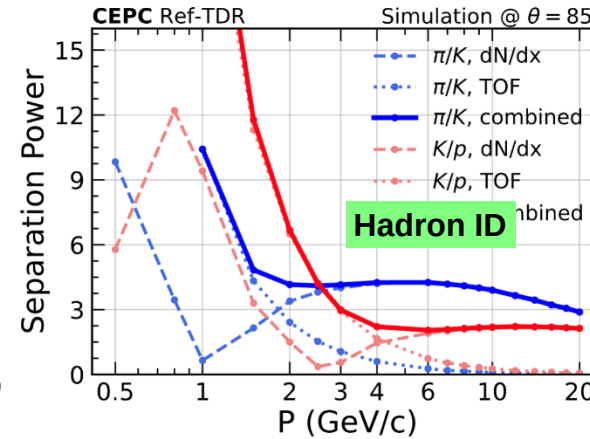
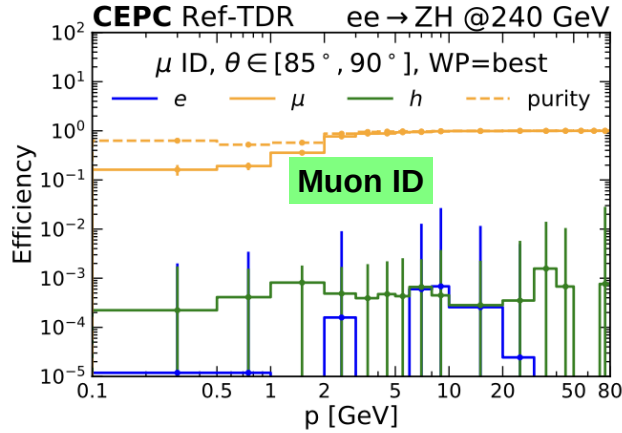
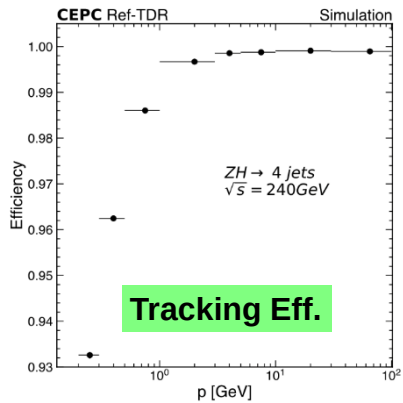
SR Power Per Beam	Luminosity/IP [$\times 10^{34} \text{cm}^{-2} \text{s}^{-1}$]				
	H	Z (2T)	Z(3T)	W^+W^-	$t\bar{t}$
30 MW	5.0	115	50.3	16	0.5
50 MW	8.3	192	95.2	26.7	0.8

2 yrs

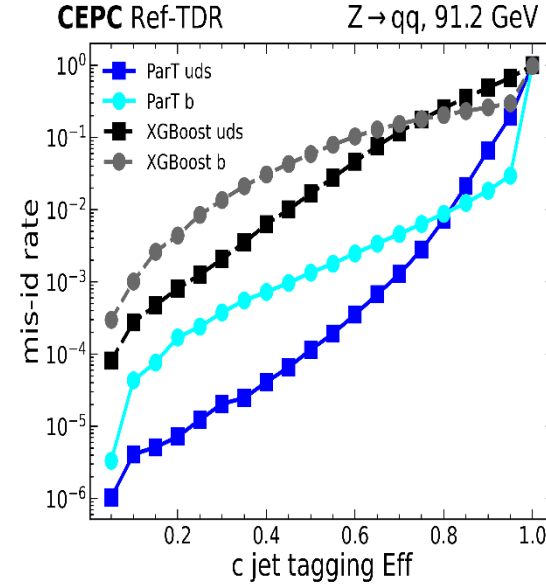
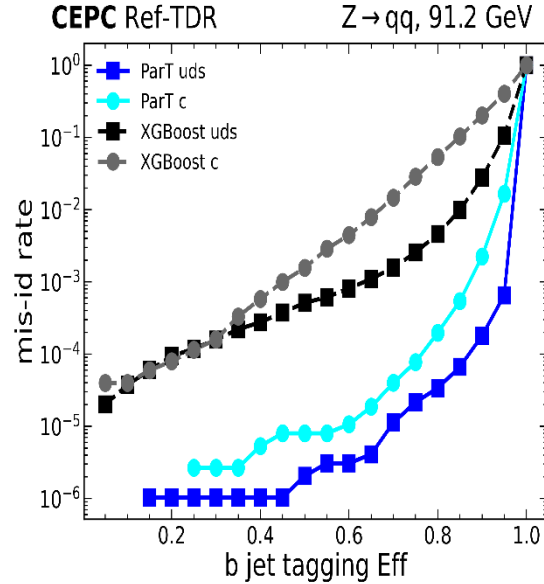
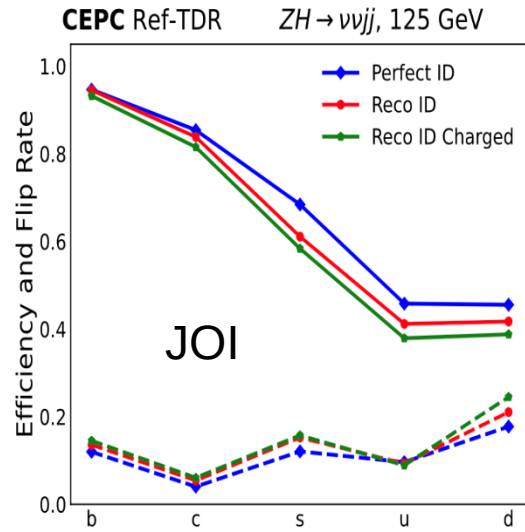
1 yr

5 yrs

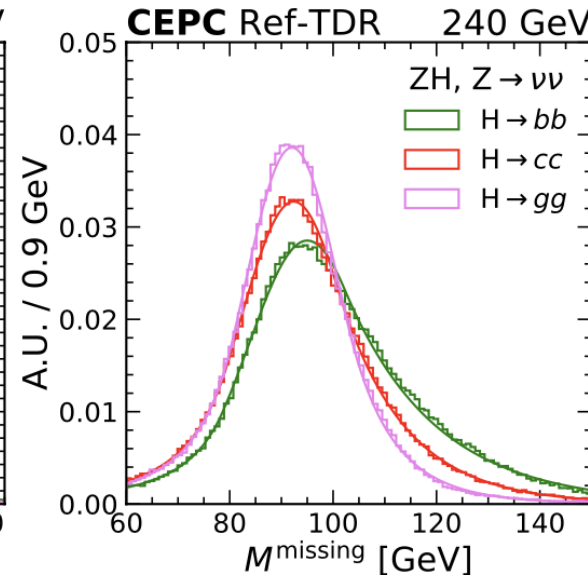
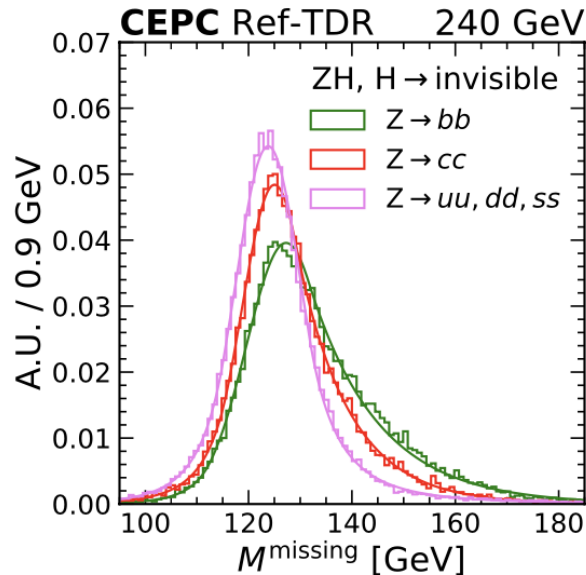
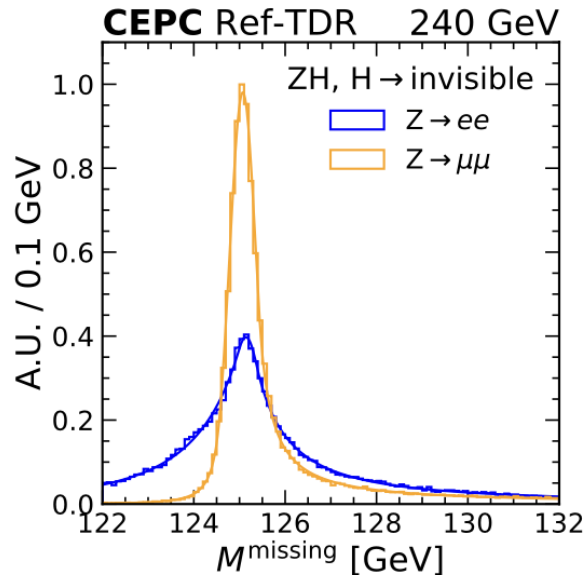
- After the first 10-year operation, the accelerator may be upgraded for High-Lumi Z mode and/or $t\bar{t}$ mode, subject to physics needs
- While the majority of the detector system remain, some sub-systems may be upgraded.
 - VTX: radiation hardness must likely is not an issue. However, new technology may bring in much better performance
 - TPC: to deal with high luminosity
 - Backend electronics and trigger system: to deal with much increased data rate



Tracking eff	Tracking σ_{pT}	VTX $\sigma_{x,y,z}$	π/K sep.	EM resl.	BMR
>99.7% (for $p>1 \text{ GeV}$)	~0.1%	< 3.5 mm	3σ (1-20 GeV)	$1.5\%/\sqrt{E}$ $\oplus 0.25\%$	3.87% (H->gg)



JOI performance is about one order of magnitude better compared to the BDT method.



Excellent missing mass reconstruction due to precise energy and momentum measurements, large coverage of the solid angle, and full knowledge of the initial state.